

# LPC2290

16/32-bit ARM microcontroller with CAN, 10-bit ADC and external memory interface

Rev. 03 — 16 November 2006

**Product data sheet** 

# 1. General description

The LPC2290 microcontroller is based on a 16/32-bit ARM7TDMI-S CPU with real-time emulation and embedded trace support. For critical code size applications, the alternative 16-bit Thumb mode reduces code by more than 30 % with minimal performance penalty.

With its 144-pin package, low power consumption, various 32-bit timers, 8-channel 10-bit ADC, two advanced CAN channels, PWM channels and up to nine external interrupt pins this microcontroller is particularly suitable for automotive and industrial control applications as well as medical systems and fault-tolerant maintenance buses. The LPC2290 provides up to 76 GPIOs depending on bus configuration. With a wide range of additional serial communications interfaces, it is also suited for communication gateways and protocol converters as well as many other general-purpose applications.

**Remark:** Throughout the data sheet, the term 'LPC2290' will apply to devices with and without the /01 suffix. New devices will use the /01 suffix to differentiate from the original devices only when necessary.

# 2. Features

# 2.1 Enhancements introduced with LPC2290/01 device

- CPU clock up to 72 MHz and 64 kB of on-chip static RAM.
- Fast GPIO ports enable port pin toggling up to 3.5 times faster than the original LPC2290. A port pin can be read at any time regardless of its function.
- Dedicated result registers for ADC reduce interrupt overhead.
- UART0/1 include fractional baud rate generator, auto-bauding capabilities and handshake flow-control fully implemented in hardware.
- SSP serial controller supporting SPI, 4-wire SSI, and Microwire buses.

# 2.2 Key features common for LPC2290 and LPC2290/01

- 16/32-bit ARM7TDMI-S microcontroller in a LQFP144 package.
- 16/64 kB on-chip static RAM.
- Serial bootloader using UART0 provides in-system download and programming capabilities.
- EmbeddedICE-RT and Embedded Trace interfaces offer real-time debugging with the on-chip RealMonitor software as well as high-speed real-time tracing of instruction execution.
- Two interconnected CAN interfaces with advanced acceptance filters. Additional serial interfaces include two UARTs (16C550), Fast I<sup>2</sup>C-bus (400 kbit/s) and two SPIs.



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- Eight channel 10-bit ADC with conversion time as low as 2.44 μs.
- Two 32-bit timers (with four capture and four compare channels), PWM unit (six outputs), Real-Time Clock (RTC) and watchdog.
- Vectored Interrupt Controller (VIC) with configurable priorities and vector addresses.
- Configurable external memory interface with up to four banks, each up to 16 MB and 8/16/32-bit data width.
- Up to 76 general purpose I/O pins (5 V tolerant). Up to nine edge/level sensitive external interrupt pins available.
- 60/72 MHz maximum CPU clock available from programmable on-chip PLL with settling time of 100 μs.
- On-chip crystal oscillator with an operating range of 1 MHz to 30 MHz.
- Power saving modes include Idle and Power-down.
- Processor wake-up from Power-down mode via external interrupt.
- Individual enable/disable of peripheral functions for power optimization.
- Dual power supply:
  - CPU operating voltage range of 1.65 V to 1.95 V (1.8 V  $\pm$  0.15 V).
  - $\blacklozenge$  I/O power supply range of 3.0 V to 3.6 V (3.3 V  $\pm$  10 %) with 5 V tolerant I/O pads.

# 3. Ordering information

Table 1. Ordering information					
Type number	Package				
	Name	Description	Version		
LPC2290FBD144	LQFP144	plastic low profile quad flat package; 144 leads; body $20 \times 20 \times 1.4$ mm	SOT486-1		
LPC2290FBD144/01	LQFP144	plastic low profile quad flat package; 144 leads; body $20 \times 20 \times 1.4$ mm	SOT486-1		

# 3.1 Ordering options

#### Table 2. Ordering options

-				
Type number	RAM	CAN	Enhancements	Temperature range
LPC2290FBD144	16 kB	2 channels	None	–40 °C to +85 °C
LPC2290FBD144/01	64 kB	2 channels	Higher CPU clock, more on-chip SRAM, Fast I/Os, improved UARTs, added SSP, upgraded ADC	–40 °C to +85 °C

# 4. Block diagram

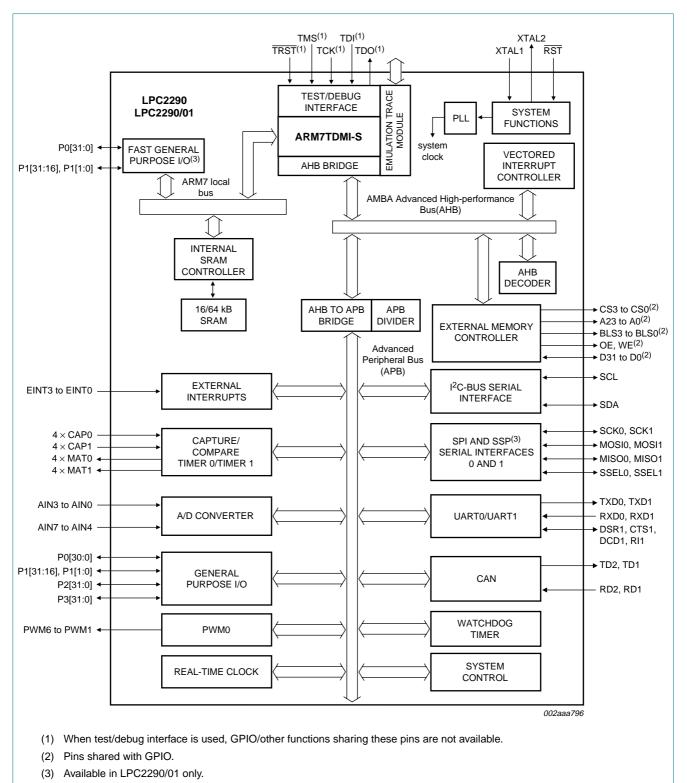
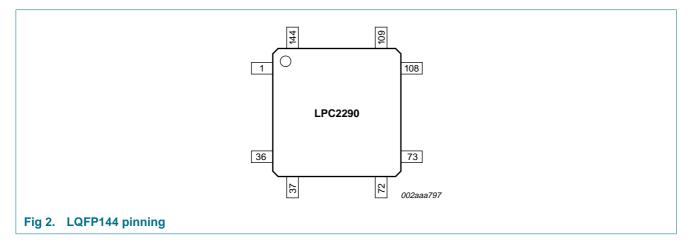


Fig 1. Block diagram

# 5. Pinning information

# 5.1 Pinning



# 5.2 Pin description

Table 3. Pin c	description		
Symbol	Pin	Туре	Description
P0.0 to P0.31		I/O	<b>Port 0:</b> Port 0 is a 32-bit bidirectional I/O port with individual direction controls for each bit. The operation of port 0 pins depends upon the pin function selected via the Pin Connect Block.
			Pins 26 and 31 of port 0 are not available.
P0.0/TXD0/	42 <mark>[1]</mark>	I/O	P0.0 — General purpose digital input/output pin.
PWM1		0	<b>TXD0</b> — Transmitter output for UART0.
		0	<b>PWM1</b> — Pulse Width Modulator output 1.
P0.1/RXD0/	49 <u>[2]</u>	I/O	P0.1 — General purpose digital input/output pin.
PWM3/EINT0		I	<b>RXD0</b> — Receiver input for UART0.
		0	<b>PWM3</b> — Pulse Width Modulator output 3.
		I	EINT0 — External interrupt 0 input
P0.2/SCL/	50 <mark>[3]</mark>	I/O	P0.2 — General purpose digital input/output pin.
CAP0.0		I/O	<b>SCL</b> — I <sup>2</sup> C-bus clock input/output. Open-drain output (for I <sup>2</sup> C-bus compliance).
		I	CAP0.0 — Capture input for Timer 0, channel 0.
P0.3/SDA/	58 <mark>3</mark>	I/O	P0.3 — General purpose digital input/output pin.
MAT0.0/EINT1		I/O	<b>SDA</b> — I <sup>2</sup> C-bus data input/output. Open-drain output (for I <sup>2</sup> C-bus compliance).
		0	MAT0.0 — Match output for Timer 0, channel 0.
		Ι	EINT1 — External interrupt 1 input.
P0.4/SCK0/	59 <mark>[1]</mark>	I/O	P0.4 — General purpose digital input/output pin.
CAP0.1		I/O	<b>SCK0</b> — Serial clock for SPI0. SPI clock output from master or input to slave.
		Ι	CAP0.1 — Capture input for Timer 0, channel 1.
P0.5/MISO0/	61 <u>[1]</u>	I/O	P0.5 — General purpose digital input/output pin.
MAT0.1		I/O	<b>MISO0</b> — Master In Slave OUT for SPI0. Data input to SPI master or data output from SPI slave.
		0	<b>MAT0.1</b> — Match output for Timer 0, channel 1.
P0.6/MOSI0/	68 <mark>[1]</mark>	I/O	P0.6 — General purpose digital input/output pin.
CAP0.2		I/O	<b>MOSI0</b> — Master Out Slave In for SPI0. Data output from SPI master or data input to SPI slave.
		I	CAP0.2 — Capture input for Timer 0, channel 2.
P0.7/SSEL0/	69 <mark>[2]</mark>	I/O	P0.7 — General purpose digital input/output pin.
PWM2/EINT2		Ι	SSEL0 — Slave Select for SPI0. Selects the SPI interface as a slave.
		0	<b>PWM2</b> — Pulse Width Modulator output 2.
		I	EINT2 — External interrupt 2 input.
P0.8/TXD1/	75 <mark>[1]</mark>	I/O	P0.8 — General purpose digital input/output pin.
PWM4		0	<b>TXD1</b> — Transmitter output for UART1.
		0	<b>PWM4</b> — Pulse Width Modulator output 4.

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Symbol	Pin	Туре	Description
P0.9/RXD1/	76 <mark>[2]</mark>	I/O	P0.9 — General purpose digital input/output pin.
PWM6/EINT3		I	<b>RXD1</b> — Receiver input for UART1.
		0	PWM6 — Pulse Width Modulator output 6.
		I	EINT3 — External interrupt 3 input.
P0.10/RTS1/	78 <u>[1]</u>	I/O	P0.10 — General purpose digital input/output pin.
CAP1.0		0	RTS1 — Request to Send output for UART1.
		I	CAP1.0 — Capture input for Timer 1, channel 0.
P0.11/CTS1/	83 <u>[1]</u>	I/O	P0.11 — General purpose digital input/output pin.
CAP1.1		I	CTS1 — Clear to Send input for UART1.
		I	CAP1.1 — Capture input for Timer 1, channel 1.
P0.12/DSR1/	84 <u>[1]</u>	I/O	P0.12 — General purpose digital input/output pin.
MAT1.0		I	DSR1 — Data Set Ready input for UART1.
		0	MAT1.0 — Match output for Timer 1, channel 0.
P0.13/DTR1/	85 <u>[1]</u>	I/O	P0.13 — General purpose digital input/output pin.
MAT1.1		0	<b>DTR1</b> — Data Terminal Ready output for UART1.
		0	MAT1.1 — Match output for Timer 1, channel 1.
P0.14/DCD1/	92[2]	I/O	P0.14 — General purpose digital input/output pin.
EINT1			DCD1 — Data Carrier Detect input for UART1.
			EINT1 — External interrupt 1 input.
			<b>Note:</b> LOW on this pin while RESET is LOW forces on-chip bootloader to take over control of the part after reset.
P0.15/RI1/	99 <mark>[2]</mark>	I/O	P0.15 — General purpose digital input/output pin.
EINT2		I	RI1 — Ring Indicator input for UART1.
		I	EINT2 — External interrupt 2 input.
P0.16/EINT0/	100[2]	I/O	P0.16 — General purpose digital input/output pin.
MAT0.2/CAP0.2		I	EINT0 — External interrupt 0 input.
		0	MAT0.2 — Match output for Timer 0, channel 2.
		I	CAP0.2 — Capture input for Timer 0, channel 2.
P0.17/CAP1.2/	101 <mark>[1]</mark>	I/O	P0.17 — General purpose digital input/output pin.
SCK1/MAT1.2		I	CAP1.2 — Capture input for Timer 1, channel 2.
		I/O	<b>SCK1</b> — Serial Clock for SPI1/SSP. SPI clock output from master or input to slave (SSP is available in LPC2290/01 only).
		0	MAT1.2 — Match output for Timer 1, channel 2.
P0.18/CAP1.3/	121 <mark>[1]</mark>	I/O	P0.18 — General purpose digital input/output pin.
MISO1/MAT1.3			CAP1.3 — Capture input for Timer 1, channel 3.
		I/O	<b>MISO1</b> — Master In Slave Out for SPI1/SSP. Data input to SPI master or data output from SPI slave (SSP is available in LPC2290/01 only).
		0	MAT1.3 — Match output for Timer 1, channel 3.

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Symbol	Pin	Туре	Description
P0.19/MAT1.2/	122 <mark>1]</mark>	I/O	P0.19 — General purpose digital input/output pin.
MOSI1/CAP1.2		0	MAT1.2 — Match output for Timer 1, channel 2.
		I/O	<b>MOSI1</b> — Master Out Slave In for SPI1/SSP. Data output from SPI master o data input to SPI slave (SSP is available in LPC2290/01 only).
			CAP1.2 — Capture input for Timer 1, channel 2.
P0.20/MAT1.3/	123 <mark>[2]</mark>	I/O	P0.20 — General purpose digital input/output pin.
SSEL1/EINT3		0	MAT1.3 — Match output for Timer 1, channel 3.
		I	<b>SSEL1</b> — Slave Select for SPI1/SSP. Selects the SPI interface as a slave (SSP is available in LPC2290/01 only).
		I	EINT3 — External interrupt 3 input.
P0.21/PWM5/	4 <u>[1]</u>	I/O	P0.21 — General purpose digital input/output pin.
CAP1.3		0	<b>PWM5</b> — Pulse Width Modulator output 5.
		I	<b>CAP1.3</b> — Capture input for Timer 1, channel 3.
P0.22/CAP0.0/	5 <u>[1]</u>	I/O	P0.22 — General purpose digital input/output pin.
MAT0.0		I	CAP0.0 — Capture input for Timer 0, channel 0.
		0	MAT0.0 — Match output for Timer 0, channel 0.
P0.23/RD2	6 <mark>[1]</mark>	I/O	P0.23 — General purpose digital input/output pin.
		l	RD2 — CAN2 receiver input.
P0.24/TD2	8 <mark>[1]</mark>	I/O	P0.24 — General purpose digital input/output pin.
		0	TD2 — CAN2 transmitter output.
P0.25	21 <mark>[1]</mark>	I/O	P0.25 — General purpose digital input/output pin.
		I	RD1 — CAN1 receiver input.
P0.27/AIN0/	23 <mark>[4]</mark>	I/O	P0.27 — General purpose digital input/output pin.
CAP0.1/MAT0.1		I	AIN0 — ADC, input 0. This analog input is always connected to its pin.
		I	<b>CAP0.1</b> — Capture input for Timer 0, channel 1.
		0	<b>MAT0.1</b> — Match output for Timer 0, channel 1.
P0.28/AIN1/	25 <u><sup>[4]</sup></u>	I/O	P0.28 — General purpose digital input/output pin.
CAP0.2/MAT0.2		l	AIN1 — ADC, input 1. This analog input is always connected to its pin.
		I	CAP0.2 — Capture input for Timer 0, channel 2.
		0	<b>MAT0.2</b> — Match output for Timer 0, channel 2.
P0.29/AIN2/	32 <mark>[4]</mark>	I/O	P0.29 — General purpose digital input/output pin.
CAP0.3/MAT0.3		l	AIN2 — ADC, input 2. This analog input is always connected to its pin.
		I	CAP0.3 — Capture input for Timer 0, Channel 3.
		0	<b>MAT0.3</b> — Match output for Timer 0, channel 3.
P0.30/AIN3/	33 <mark>[4]</mark>	I/O	P0.30 — General purpose digital input/output pin.
EINT3/CAP0.0		I	AIN3 — ADC, input 3. This analog input is always connected to its pin.
		I	EINT3 — External interrupt 3 input.
		I	CAP0.0 — Capture input for Timer 0, channel 0.
P1.0 to P1.31		I/O	<b>Port 1:</b> Port 1 is a 32-bit bidirectional I/O port with individual direction controls for each bit. The operation of port 1 pins depends upon the pin function selected via the Pin Connect Block.

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Symbol	Pin	Туре	Description
P1.0/CS0	91 <u>5</u>	1/0	P1.0 — General purpose digital input/output pin.
,	-	0	<b>CS0</b> — LOW-active Chip Select 0 signal.
		-	(Bank 0 addresses range 0x8000 0000 to 0x80FF FFFF)
P1.1/OE	90 <mark>[5]</mark>	I/O	P1.1 — General purpose digital input/output pin.
		0	<b>OE</b> — LOW-active Output Enable signal.
P1.16/	34 <u>[5]</u>	I/O	P1.16 — General purpose digital input/output pin.
TRACEPKT0		0	TRACEPKT0 — Trace Packet, bit 0. Standard I/O port with internal pull-up
P1.17/	24 <mark>5</mark>	I/O	P1.17 — General purpose digital input/output pin.
TRACEPKT1		0	TRACEPKT1 — Trace Packet, bit 1. Standard I/O port with internal pull-up
P1.18/	15 <mark>5</mark>	I/O	P1.18 — General purpose digital input/output pin.
TRACEPKT2		0	TRACEPKT2 — Trace Packet, bit 2. Standard I/O port with internal pull-up
P1.19/	7 <u>[5]</u>	I/O	P1.19 — General purpose digital input/output pin.
TRACEPKT3		0	TRACEPKT3 — Trace Packet, bit 3. Standard I/O port with internal pull-up
P1.20/	102[5]	I/O	P1.20 — General purpose digital input/output pin.
TRACESYNC		0	<b>TRACESYNC</b> — Trace Synchronization. Standard I/O port with internal pull-up.
			<b>Note:</b> LOW on this pin while RESET is LOW, enables pins P1[25:16] to operate as Trace port after reset.
P1.21/	95 <mark>5</mark>	I/O	P1.21 — General purpose digital input/output pin.
PIPESTAT0		0	PIPESTAT0 — Pipeline Status, bit 0. Standard I/O port with internal pull-u
P1.22/	86 <u>[5]</u>	I/O	P1.22 — General purpose digital input/output pin.
PIPESTAT1		0	PIPESTAT1 — Pipeline Status, bit 1. Standard I/O port with internal pull-u
P1.23/	82 <mark>5</mark>	I/O	P1.23 — General purpose digital input/output pin.
PIPESTAT2		0	PIPESTAT2 — Pipeline Status, bit 2. Standard I/O port with internal pull-u
P1.24/	70 <mark>5</mark>	I/O	P1.24 — General purpose digital input/output pin.
TRACECLK		0	<b>TRACECLK</b> — Trace Clock. Standard I/O port with internal pull-up.
P1.25/EXTIN0	60 <u>[5]</u>	I/O	P1.25 — General purpose digital input/output pin.
		I	EXTINO — External Trigger Input. Standard I/O with internal pull-up.
P1.26/RTCK	52 <mark>5</mark>	I/O	P1.26 — General purpose digital input/output pin.
		I/O	<b>RTCK</b> — Returned Test Clock output. Extra signal added to the JTAG port Assists debugger synchronization when processor frequency varies. Bidirectional pin with internal pull-up.
			<b>Note:</b> LOW on this pin while RESET is LOW, enables pins P1[31:26] to operate as Debug port after reset.
P1.27/TDO	144 <mark>5]</mark>	I/O	P1.27 — General purpose digital input/output pin.
		0	<b>TDO</b> — Test Data out for JTAG interface.
P1.28/TDI	140[5]	I/O	P1.28 — General purpose digital input/output pin.
		Ι	<b>TDI</b> — Test Data in for JTAG interface.
P1.29/TCK	126 <mark>5]</mark>	I/O	P1.29 — General purpose digital input/output pin.
		I	TCK — Test Clock for JTAG interface.
P1.30/TMS	113 <mark>5</mark>	I/O	P1.30 — General purpose digital input/output pin.
-		I	<b>TMS</b> — Test Mode Select for JTAG interface.

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## 16/32-bit ARM microcontroller with external memory interface

P1.31/TRST       438       I/O       P1.31 — General purpose digital input/output pin.         P2.0 to P2.31       I/O       Port 2 — Port 2 is a 32-bit bidirectional I/O port with individual direction selected via the Pin Connect Block.         P2.0/D0       98       I/O       P2.0 — General purpose digital input/output pin.         I/O       D0 — External memory data line 0.       P2.1         P2.1/D1       105       I/O       P2.1 — General purpose digital input/output pin.         I/O       D1 — External memory data line 1.       P2.2/D2         P2.3/D3       106       I/O       P2.2 — General purpose digital input/output pin.         I/O       D2 — External memory data line 2.       P2.3 — General purpose digital input/output pin.         I/O       D2 = External memory data line 3.       P2.4/D4         P2.4/D4       109       I/O       P2.4 — General purpose digital input/output pin.         I/O       D4 — External memory data line 4.       P2.5/D5         P2.4/D4       109       I/O       P2.5 — General purpose digital input/output pin.         I/O       D5 — External memory data line 5.       P2.7/D7         P2.6/D6       115       I/O       P2.7 — General purpose digital input/output pin.         I/O       D6 — External memory data line 7.       P2.9/D9	Symbol	Pin	Туре	Description
ITRST — Test Reset for JTAG interface.P2.0 to P2.31I/OPort 2 = - Port 2 is a 32-bit bidirectional I/O port whindividual direc controls for each bit. The operation of port 2 pins depends upon the function selected via the Pin Connect Block.P2.0/D09819I/OP2.0 — General purpose digital input/output pin.I/OD0 — External memory data line 0.P2.1/D110519I/OP2.1 — General purpose digital input/output pin.I/OD1 — External memory data line 1.P2.2/D210619I/OP2.2 — General purpose digital input/output pin.I/OD2 — External memory data line 2.P2.3/D310819I/OP2.4 — General purpose digital input/output pin.I/OD3 — External memory data line 3.P2.4/D410919I/OP2.4 — General purpose digital input/output pin.I/OD4 — External memory data line 4.P2.5/D511419I/OP2.6 — General purpose digital input/output pin.I/OD5 — External memory data line 5.P2.6/D611519I/OP2.6 — General purpose digital input/output pin.I/OD6 — External memory data line 6.P2.7/D711619I/OP2.4 — General purpose digital input/output pin.I/OD7 — External memory data line 8.P2.9/D811719I/OP2.8 — General purpose digital input/output pin.I/OD7 — External memory data line 8.P2.9/D1012019I/OP2.1 — General purpose digital input/output pin.I/OD9 — External memory data line 10.P2.11/D11 <t< td=""><td>-</td><td></td><td></td><td></td></t<>	-			
P2.0 to P2.31I/OPort 2 — Port 2 is a 32-bit bidirectional I/O port with individual direc controls for each bit. The operation of port 2 pins depends upon the function selected via the Pin Connect Block.P2.0/D098/9I/OP2.0 — General purpose digital input/output pin.I/OD0 — External memory data line 0.P2.1/D1105/9I/OP2.1 — General purpose digital input/output pin.I/OD1 — External memory data line 1.P2.2/D2106/9I/OP2.2 — General purpose digital input/output pin.I/OD2 — External memory data line 2.P2.3/D3108/9I/OP2.3 — General purpose digital input/output pin.I/OD3 — External memory data line 3.P2.4/D4109/9I/OP2.4 — General purpose digital input/output pin.I/OD4 — External memory data line 4.P2.5/D5114/9I/OP2.5 — General purpose digital input/output pin.I/OD5 — External memory data line 6.P2.6/D6115/9I/OP2.7 — General purpose digital input/output pin.I/OD6 — External memory data line 6.P2.7/D7116/9I/OP2.7 — General purpose digital input/output pin.I/OD7 — External memory data line 7.P2.4/D4I/OP2.9 — General purpose digital input/output pin.I/OD7 — External memory data line 7.P2.1/D10120/9I/OP2.1 — General purpose digital input/output pin.I/OD7 — External memory data line 8.P2.1/D10120/9I/OP2.1 — General purpose digital input/output pin. <td>1 1.01/11(0</td> <td></td> <td></td> <td></td>	1 1.01/11(0			
I/OD0 — External memory data line 0.P2.1/D1105 <sup>[2]</sup> I/OP2.1 — General purpose digital input/output pin.I/OD1 — External memory data line 1.P2.2/D2106 <sup>[3]</sup> I/OP2.2 — General purpose digital input/output pin.I/OD2 — External memory data line 2.P2.3/D3108 <sup>[3]</sup> I/OP2.4 — General purpose digital input/output pin.I/OD3 — External memory data line 3.P2.4/D4109 <sup>[5]</sup> I/OP2.4 — General purpose digital input/output pin.I/OD4 — External memory data line 4.P2.5/D5114 <sup>[6]</sup> I/OP2.5 — General purpose digital input/output pin.I/OD5 — External memory data line 6.P2.6/D6115 <sup>[6]</sup> I/OP2.6 — General purpose digital input/output pin.I/OD6 — External memory data line 6.P2.7/D7116 <sup>[5]</sup> I/OP2.7 — General purpose digital input/output pin.I/OD7 — External memory data line 7.P2.8/D8117 <sup>[6]</sup> I/OP2.8 — General purpose digital input/output pin.I/OD8 — External memory data line 8.P2.9/D9118 <sup>[6]</sup> I/OP2.10 — General purpose digital input/output pin.I/OD9 — External memory data line 9.P2.10/D10120 <sup>[9]</sup> I/OP2.11 — General purpose digital input/output pin.I/OD10 — External memory data line 10.P2.11/D11124 <sup>[9]</sup> I/OP2.12 — General purpose digital input/output pin.I/OD10 — External memory data line 12.P2.13/D13 <td< td=""><td>P2.0 to P2</td><td>2.31</td><td>-</td><td><b>Port 2</b> — Port 2 is a 32-bit bidirectional I/O port with individual direction controls for each bit. The operation of port 2 pins depends upon the pin</td></td<>	P2.0 to P2	2.31	-	<b>Port 2</b> — Port 2 is a 32-bit bidirectional I/O port with individual direction controls for each bit. The operation of port 2 pins depends upon the pin
P2.1/D1       105       I/O       P2.1 — General purpose digital input/output pin.         P2.2/D2       106       I/O       P2.2 — General purpose digital input/output pin.         P2.3/D3       108       I/O       P2.2 — General purpose digital input/output pin.         I/O       D2 — External memory data line 2.         P2.3/D3       108       I/O       P2.3 — General purpose digital input/output pin.         I/O       D3 — External memory data line 3.       P2.4/D4       109       P2.4 — General purpose digital input/output pin.         P2.4/D4       109       I/O       P2.4 — General purpose digital input/output pin.       I/O       D4 — External memory data line 3.         P2.6/D6       114       I/O       P2.6 — General purpose digital input/output pin.       I/O       D5 — External memory data line 4.         P2.6/D6       115       I/O       P2.6 — General purpose digital input/output pin.       I/O       D6 — External memory data line 6.         P2.7/D7       116       I/O       P2.7 — General purpose digital input/output pin.       I/O       D8 — External memory data line 7.         P2.8/D8       117       I/O       P2.8 — General purpose digital input/output pin.       I/O       D8 — External memory data line 9.         P2.10/D10       120       I/O       P2.1 — General purpose digital inpu	P2.0/D0	98 <mark>5]</mark>	I/O	P2.0 — General purpose digital input/output pin.
I/OD1 — External memory data line 1.P2.2/D2106I/OP2.2 — General purpose digital input/output pin.I/OD2 — External memory data line 2.P2.3/D3108I/OP2.3 — General purpose digital input/output pin.I/OD3 — External memory data line 3.P2.4/D4109I/OP2.4 — General purpose digital input/output pin.I/OD4 — External memory data line 4.P2.5/D5114I/OP2.5 — General purpose digital input/output pin.I/OD5 — External memory data line 5.P2.6/D6115I/OP2.6 — General purpose digital input/output pin.I/OD6 — External memory data line 6.P2.7/D7116I/OP2.7 — General purpose digital input/output pin.I/OD7 — External memory data line 6.P2.7/D7116I/OP2.6 — General purpose digital input/output pin.I/OD7 — External memory data line 7.P2.8/D8117I/OP2.8 — General purpose digital input/output pin.I/OD8 — External memory data line 8.P2.9/D9118I/OP2.9 — General purpose digital input/output pin.I/OD9 — External memory data line 9.P2.10/D10120I/OP2.10 — General purpose digital input/output pin.I/OD10 — External memory data line 10.P2.11/D11120I/OP2.11 — General purpose digital input/output pin.I/OD11 — External memory data line 11.P2.12/D12125I/OP2.13 — General purpose digital			I/O	<b>D0</b> — External memory data line 0.
P2.2/D2106I/OP2.2 — General purpose digital input/output pin. I/OD2 — External memory data line 2.P2.3/D3108I/OP2.3 — General purpose digital input/output pin. I/OD3 — External memory data line 3.P2.4/D4109I/OP2.4 — General purpose digital input/output pin. I/OD4 — External memory data line 4.P2.5/D5114I/OP2.5 — General purpose digital input/output pin. I/OD5 — External memory data line 5.P2.6/D6115I/OP2.6 — General purpose digital input/output pin. I/OD6 — External memory data line 6.P2.7/D7116I/OP2.7 — General purpose digital input/output pin. I/OD6 — External memory data line 6.P2.7/D7116I/OP2.7 — General purpose digital input/output pin. I/OD7 — External memory data line 7.P2.8/D8117I/OP2.8 — General purpose digital input/output pin. I/OD7 — External memory data line 8.P2.9/D9118I/OP2.9 — General purpose digital input/output pin. I/OD9 — External memory data line 8.P2.10/D10120I/OP2.10 — General purpose digital input/output pin. I/OD9 — External memory data line 10.P2.11/D11124I/OP2.11 — General purpose digital input/output pin. I/OD10 — External memory data line 11.P2.12/D12125I/OP2.13 — General purpose digital input/output pin. I/OD11 — External memory data line 13.P2.14/D14129I/OP2.14 — General purpose digital input/output pin. I/OD12 — External memory data line 14.	P2.1/D1	105 <mark>5]</mark>	I/O	P2.1 — General purpose digital input/output pin.
I/OD2 — External memory data line 2.P2.3/D3108I/OP2.3 — General purpose digital input/output pin.I/OD3 — External memory data line 3.P2.4/D4109I/OP2.4 — General purpose digital input/output pin.I/OD4 — External memory data line 4.P2.5/D5114I/OP2.5 — General purpose digital input/output pin.I/OD5 — External memory data line 5.P2.6/D6115I/OP2.6 — General purpose digital input/output pin.I/OD6 — External memory data line 6.P2.7/D7116I/OP2.7 — General purpose digital input/output pin.I/OD7 — External memory data line 7.P2.8/D8117I/OP2.8 — General purpose digital input/output pin.I/OD7 — External memory data line 8.P2.9/D9118I/OP2.9 — General purpose digital input/output pin.I/OD9 — External memory data line 9.P2.10/D1120I/OP2.10 — General purpose digital input/output pin.I/OD10 — External memory data line 10.P2.11/D11124I/OP2.11 — General purpose digital input/output pin.I/OD11 — External memory data line 11.P2.13/D13127I/OP2.13 — General purpose digital input/output pin.I/OD12 — External memory data line 13.P2.14/D14129I/OP2.14 — General purpose digital input/output pin.I/OD13 — External memory data line 14.P2.15/D15130I/OP2.14 — General purpos			I/O	D1 — External memory data line 1.
P2.3/D3       108 <sup>[3]</sup> I/O       P2.3 — General purpose digital input/output pin.         P2.4/D4       109 <sup>[5]</sup> I/O       P2.4 — General purpose digital input/output pin.         I/O       D4 — External memory data line 3.         P2.5/D5       114 <sup>[5]</sup> I/O       P2.5 — General purpose digital input/output pin.         I/O       D5 — External memory data line 5.         P2.6/D6       115 <sup>[6]</sup> I/O       P2.6 — General purpose digital input/output pin.         I/O       D6 — External memory data line 6.         P2.7/D7       116 <sup>[6]</sup> I/O       P2.7 — General purpose digital input/output pin.         I/O       D6 — External memory data line 7.       P2.8/D8       I/O       P2.8 — General purpose digital input/output pin.         I/O       D7 — External memory data line 8.       P2.9/D9       118 <sup>[3]</sup> I/O       P2.9 — General purpose digital input/output pin.         I/O       D8 — External memory data line 8.       P2.9/D9       118 <sup>[3]</sup> I/O       P2.10 — General purpose digital input/output pin.         I/O       D9 — External memory data line 10.       P2.10 — General purpose digital input/output pin.       I/O       D10 — External memory data line 10.         P2.11/D11       124 <sup>[5]</sup> I/O       P2.11 — General purpose digital input/output pin.       I/O       D11 —	P2.2/D2	106 <mark>5]</mark>	I/O	P2.2 — General purpose digital input/output pin.
I/OD3 — External memory data line 3.P2.4/D4109[2]I/OP2.4 — General purpose digital input/output pin.I/OD4 — External memory data line 4.P2.5/D5114[2]I/OP2.5 — General purpose digital input/output pin.I/OD5 — External memory data line 5.P2.6/D6115[3]I/OP2.6 — General purpose digital input/output pin.I/OD6 — External memory data line 6.P2.7/D7116[3]I/OP2.7 — General purpose digital input/output pin.I/OD7 — External memory data line 7.P2.8/D8117[3]I/OP2.8 — General purpose digital input/output pin.I/OD8 — External memory data line 8.P2.9/D9118[3]I/OP2.9 — General purpose digital input/output pin.I/OD9 — External memory data line 9.P2.10/D10120[3]I/OP2.10 — General purpose digital input/output pin.I/OD10 — External memory data line 10.P2.11/D11124[5]I/OP2.11 — General purpose digital input/output pin.I/OD10 — External memory data line 11.P2.12/D12125[3]I/OP2.12 — General purpose digital input/output pin.I/OD11 — External memory data line 13.P2.13/D13127[3]I/OP2.14 — General purpose digital input/output pin.I/OD12 — External memory data line 14.P2.14/D14129[3]I/OP2.14 — General purpose digital input/output pin.I/OD14 — External memory data line 14.P2.15/D15130[3]<			I/O	D2 — External memory data line 2.
P2.4/D4       109[5]       I/O       P2.4 — General purpose digital input/output pin.         I/O       D4 — External memory data line 4.         P2.5/D5       114[5]       I/O       P2.5 — General purpose digital input/output pin.         I/O       D5 — External memory data line 5.         P2.6/D6       115[5]       I/O       P2.6 — General purpose digital input/output pin.         I/O       D6 — External memory data line 6.         P2.7/D7       116[5]       I/O       P2.7 — General purpose digital input/output pin.         I/O       D7 — External memory data line 7.         P2.8/D8       117[5]       I/O       P2.8 — General purpose digital input/output pin.         I/O       D7 — External memory data line 8.       P2.9         P2.8/D8       117[5]       I/O       P2.9 — General purpose digital input/output pin.         I/O       D9 — External memory data line 8.       P2.9         P2.10/D10       120[5]       I/O       P2.10 — General purpose digital input/output pin.         I/O       D10 — External memory data line 9.       P2.11 — General purpose digital input/output pin.         I/O       D10 — External memory data line 10.       P2.12 — General purpose digital input/output pin.         I/O       D11 — External memory data line 11.       P2.12 — General purpose digital input/outpu	P2.3/D3	108 <mark>5</mark>	I/O	P2.3 — General purpose digital input/output pin.
I/O         D4 — External memory data line 4.           P2.5/D5         114 <sup>[5]</sup> I/O         P2.5 — General purpose digital input/output pin.           I/O         D5 — External memory data line 5.           P2.6/D6         115 <sup>[5]</sup> I/O         P2.6 — General purpose digital input/output pin.           I/O         D6 — External memory data line 6.         P2.7 — General purpose digital input/output pin.           I/O         D7 — External memory data line 7.           P2.8/D8         117 <sup>[5]</sup> I/O         P2.8 — General purpose digital input/output pin.           I/O         D7 — External memory data line 8.         P2.9 — General purpose digital input/output pin.           P2.9/D9         118 <sup>[5]</sup> I/O         P2.9 — General purpose digital input/output pin.           I/O         D9 — External memory data line 9.         P2.10/D10         120 <sup>[5]</sup> P2.10/D10         120 <sup>[5]</sup> I/O         P2.11 — General purpose digital input/output pin.           I/O         D10 — External memory data line 10.         P2.12 — General purpose digital input/output pin.           P2.12/D12         125 <sup>[5]</sup> I/O         P2.12 — General purpose digital input/output pin.           I/O         D11 — External memory data line 12.         P2.13/D13         127 <sup>[5]</sup> I/O         P2.12 — General			I/O	D3 — External memory data line 3.
P2.5/D5       114 <sup>[5]</sup> I/O       P2.5 — General purpose digital input/output pin.         IVO       D5 — External memory data line 5.         P2.6/D6       115 <sup>[5]</sup> I/O       P2.6 — General purpose digital input/output pin.         IVO       D6 — External memory data line 6.         P2.7/D7       116 <sup>[5]</sup> I/O       P2.7 — General purpose digital input/output pin.         IVO       D7 — External memory data line 7.         P2.8/D8       117 <sup>[5]</sup> I/O       P2.8 — General purpose digital input/output pin.         IVO       D7 — External memory data line 8.         P2.9/D9       118 <sup>[5]</sup> I/O       P2.9 — General purpose digital input/output pin.         IVO       D9 — External memory data line 9.       D9 — External memory data line 9.         P2.10/D10       120 <sup>[5]</sup> I/O       P2.11 — General purpose digital input/output pin.         IVO       P2.11 — General purpose digital input/output pin.       I/O         P2.12/D12       12 <sup>[5]</sup> I/O       P2.12 — General purpose digital input/output pin.         IVO       P2.12 — General purpose digital input/output pin.       I/O       D11 — External memory data line 12.         P2.12/D12       12 <sup>[5]</sup> I/O       P2.13 — General purpose digital input/output pin.         I/O       D13 — External me	P2.4/D4	109 <mark>5]</mark>	I/O	P2.4 — General purpose digital input/output pin.
I/OD5 — External memory data line 5.P2.6/D61159I/OP2.6 — General purpose digital input/output pin.I/OD6 — External memory data line 6.P2.7/D71169I/OP2.7 — General purpose digital input/output pin.I/OD7 — External memory data line 7.P2.8/D81179I/OP2.8 — General purpose digital input/output pin.I/OD8 — External memory data line 8.P2.9/D91189I/OP2.9 — General purpose digital input/output pin.I/OD9 — External memory data line 9.P2.10/D101209I/OP2.10 — General purpose digital input/output pin.I/OD10 — External memory data line 10.P2.11/D111249I/OP2.11 — General purpose digital input/output pin.I/OD11 — External memory data line 11.P2.12/D121259I/OP2.13 — General purpose digital input/output pin.I/OD12 — External memory data line 12.P2.13/D131279I/OP2.14 — General purpose digital input/output pin.I/OD13 — External memory data line 13.P2.14/D141299I/OP2.15 — General purpose digital input/output pin.I/OD14 — External memory data line 14.P2.15/D151309I/OP2.16 — General purpose digital input/output pin.I/OD15 — External memory data line 15.P2.16/D161319I/OP2.16 — General purpose digital input/output pin.I/OD15 — External memory data line 16.			I/O	D4 — External memory data line 4.
P2.6/D6115I/OP2.6 — General purpose digital input/output pin. I/OD6 — External memory data line 6.P2.7/D7116I/OP2.7 — General purpose digital input/output pin. I/OD7 — External memory data line 7.P2.8/D8117I/OP2.8 — General purpose digital input/output pin. I/OD7 — External memory data line 8.P2.9/D9118I/OP2.9 — General purpose digital input/output pin. I/OD9 — External memory data line 9.P2.10/D10120I/OP2.10 — General purpose digital input/output pin. I/OD10 — External memory data line 10.P2.11/D11124I/OP2.11 — General purpose digital input/output pin. I/OD11 — External memory data line 11.P2.12/D12125I/OP2.12 — General purpose digital input/output pin. I/OD12 — External memory data line 12.P2.13/D13127I/OP2.13 — General purpose digital input/output pin. I/OD13 — External memory data line 13.P2.14/D14129I/OP2.14 — General purpose digital input/output pin. I/OD14 — External memory data line 14.P2.15/D15130I/OP2.15 — General purpose digital input/output pin. I/OD14 — External memory data line 15.P2.16/D16131I/OP2.16 — General purpose digital input/output pin. I/OD15 — External memory data line 15.P2.16/D16131I/OP2.16 — General purpose digital input/output pin. I/OD15 — External memory data line 16.	P2.5/D5	114 <mark>5</mark>	I/O	P2.5 — General purpose digital input/output pin.
I/OD6 — External memory data line 6.P2.7/D7116[5]I/OP2.7 — General purpose digital input/output pin.I/OD7 — External memory data line 7.P2.8/D8117[5]I/OP2.8 — General purpose digital input/output pin.I/OD8 — External memory data line 8.P2.9/D9118[5]I/OP2.9 — General purpose digital input/output pin.I/OD9 — External memory data line 9.P2.10/D10120[5]I/OP2.10 — General purpose digital input/output pin.I/OD10 — External memory data line 9.P2.11/D11124[5]I/OP2.11 — General purpose digital input/output pin.I/OD10 — External memory data line 10.P2.12/D12125[5]I/OP2.12 — General purpose digital input/output pin.I/OD11 — External memory data line 11.P2.13/D13127[5]I/OP2.13 — General purpose digital input/output pin.I/OD13 — External memory data line 13.P2.14/D14129[5]I/OP2.14 — General purpose digital input/output pin.I/OD14 — External memory data line 14.P2.15/D15130[5]I/OP2.15 — General purpose digital input/output pin.I/OD15 — External memory data line 15.P2.16/D16131[5]I/OP2.16 — General purpose digital input/output pin.I/OD16 — External memory data line 16.			I/O	<b>D5</b> — External memory data line 5.
P2.7/D71165I/OP2.7 — General purpose digital input/output pin. I/OD7 — External memory data line 7.P2.8/D81175I/OP2.8 — General purpose digital input/output pin. I/OD8 — External memory data line 8.P2.9/D91185I/OP2.9 — General purpose digital input/output pin. I/OD9 — External memory data line 9.P2.10/D101205I/OP2.10 — General purpose digital input/output pin. I/OD10 — External memory data line 9.P2.10/D101205I/OP2.11 — General purpose digital input/output pin. I/OD10 — External memory data line 10.P2.11/D111245I/OP2.12 — General purpose digital input/output pin. I/OD11 — External memory data line 11.P2.12/D121255I/OP2.12 — General purpose digital input/output pin. I/OD12 — External memory data line 12.P2.13/D131275I/OP2.13 — General purpose digital input/output pin. I/OD13 — External memory data line 13.P2.14/D141295I/OP2.14 — General purpose digital input/output pin. I/OD14 — External memory data line 14.P2.15/D151305I/OP2.15 — General purpose digital input/output pin. I/OD15 — External memory data line 15.P2.16/D161315I/OP2.16 — General purpose digital input/output pin. I/OD16 — External memory data line 16.	P2.6/D6	115 <mark>5</mark>	I/O	P2.6 — General purpose digital input/output pin.
I/OD7 — External memory data line 7.P2.8/D8117[9]I/OP2.8 — General purpose digital input/output pin.I/OD8 — External memory data line 8.P2.9/D9118[9]I/OP2.9 — General purpose digital input/output pin.I/OD9 — External memory data line 9.P2.10/D10120[9]I/OP2.10 — General purpose digital input/output pin.I/OD10 — External memory data line 10.P2.11/D11124[9]I/OP2.11 — General purpose digital input/output pin.I/OD11 — External memory data line 11.P2.12/D12125[9]I/OP2.12 — General purpose digital input/output pin.I/OD11 — External memory data line 12.P2.13/D13127[9]I/OP2.13 — General purpose digital input/output pin.I/OD12 — External memory data line 13.P2.14/D14129[9]I/OP2.14 — General purpose digital input/output pin.I/OD14 — External memory data line 14.P2.15/D15130[9]I/OP2.15 — General purpose digital input/output pin.I/OD15 — External memory data line 15.P2.16/D16131[9]I/OP2.16 — General purpose digital input/output pin.I/OD15 — External memory data line 16.			I/O	
P2.8/D8 $117[5]$ I/OP2.8 — General purpose digital input/output pin. I/OD8 — External memory data line 8.P2.9/D9 $118[5]$ I/OP2.9 — General purpose digital input/output pin. I/OD9 — External memory data line 9.P2.10/D10 $120[5]$ I/OP2.10 — General purpose digital input/output pin. I/OD10 — External memory data line 10.P2.11/D11 $124[5]$ I/OP2.11 — General purpose digital input/output pin. I/OD11 — External memory data line 11.P2.12/D12 $125[5]$ I/OP2.12 — General purpose digital input/output pin. I/OD12 — External memory data line 12.P2.13/D13 $127[5]$ I/OP2.13 — General purpose digital input/output pin. I/OD13 — External memory data line 13.P2.14/D14 $129[5]$ I/OP2.14 — General purpose digital input/output pin. I/OD14 — External memory data line 14.P2.15/D15 $130[6]$ I/OP2.15 — General purpose digital input/output pin. I/OD15 — External memory data line 15.P2.16/D16 $131[6]$ I/OP2.16 — General purpose digital input/output pin. I/OD16 — External memory data line 16.	P2.7/D7	116 <mark>5</mark>	I/O	P2.7 — General purpose digital input/output pin.
I/OD8 — External memory data line 8.P2.9/D9118I/OP2.9 — General purpose digital input/output pin.I/OD9 — External memory data line 9.P2.10/D10120I/OP2.10 — General purpose digital input/output pin.I/OD10 — External memory data line 10.P2.11/D11124I/OP2.11 — General purpose digital input/output pin.I/OD11 — External memory data line 11.P2.12/D12125I/OP2.12 — General purpose digital input/output pin.I/OD12 — External memory data line 12.P2.13/D13127I/OP2.13 — General purpose digital input/output pin.I/OD13 — External memory data line 13.P2.14/D14129I/OP2.14 — General purpose digital input/output pin.I/OD14 — External memory data line 14.P2.15/D15130I/OP2.15 — General purpose digital input/output pin.I/OD14 — External memory data line 15.P2.16/D16131I/OP2.16 — General purpose digital input/output pin.I/OD15 — External memory data line 15.I/OP16 — General purpose digital input/output pin.			I/O	<b>D7</b> — External memory data line 7.
P2.9/D9118I/OP2.9 — General purpose digital input/output pin. I/OD9 — External memory data line 9.P2.10/D10120I/OP2.10 — General purpose digital input/output pin. I/OD10 — External memory data line 10.P2.11/D11124I/OP2.11 — General purpose digital input/output pin. I/OD11 — External memory data line 11.P2.12/D12125I/OP2.12 — General purpose digital input/output pin. I/OD12 — External memory data line 12.P2.13/D13127I/OP2.13 — General purpose digital input/output pin. I/OD13 — External memory data line 13.P2.14/D14129I/OP2.14 — General purpose digital input/output pin. I/OD14 — External memory data line 14.P2.15/D15130I/OP2.15 — General purpose digital input/output pin. I/OD14 — External memory data line 14.P2.16/D16131I/OP2.16 — General purpose digital input/output pin. I/OD15 — External memory data line 15.P2.16/D16131I/OP2.16 — General purpose digital input/output pin. I/OD15 — External memory data line 16.	P2.8/D8	117 <mark>5</mark>	I/O	P2.8 — General purpose digital input/output pin.
I/OD9 — External memory data line 9.P2.10/D101205I/OP2.10 — General purpose digital input/output pin.I/OD10 — External memory data line 10.P2.11/D111245I/OP2.11 — General purpose digital input/output pin.I/OD11 — External memory data line 11.P2.12/D121255I/OP2.12 — General purpose digital input/output pin.I/OD12 — External memory data line 12.P2.13/D131275I/OP2.13 — General purpose digital input/output pin.I/OD13 — External memory data line 13.P2.14/D141295I/OP2.14 — General purpose digital input/output pin.I/OD14 — External memory data line 14.P2.15/D151305I/OP2.15 — General purpose digital input/output pin.I/OD15 — External memory data line 15.P2.16/D161315I/OP2.16 — General purpose digital input/output pin.I/OD15 — External memory data line 16.				-
P2.10/D10120[5]I/OP2.10 — General purpose digital input/output pin.P2.11/D11124[5]I/OP10 — External memory data line 10.P2.11/D11124[5]I/OP2.11 — General purpose digital input/output pin.I/OD11 — External memory data line 11.P2.12/D12125[5]I/OP2.12 — General purpose digital input/output pin.I/OD12 — External memory data line 12.P2.13/D13127[5]I/OP2.13 — General purpose digital input/output pin.I/OD13 — External memory data line 13.P2.14/D14129[5]I/OP2.14 — General purpose digital input/output pin.I/OD14 — External memory data line 14.P2.15/D15130[5]I/OP2.15 — General purpose digital input/output pin.I/OD15 — External memory data line 15.P2.16/D16131[5]I/OP2.16 — General purpose digital input/output pin.I/OD16 — External memory data line 16.	P2.9/D9	118 <mark>5</mark>		P2.9 — General purpose digital input/output pin.
I/OD10 — External memory data line 10.P2.11/D11124 <sup>[5]</sup> I/OP2.11 — General purpose digital input/output pin.I/OD11 — External memory data line 11.P2.12/D12125 <sup>[5]</sup> I/OP2.12 — General purpose digital input/output pin.I/OD12 — External memory data line 12.P2.13/D13127 <sup>[5]</sup> I/OP2.13 — General purpose digital input/output pin.I/OD13 — External memory data line 13.P2.14/D14129 <sup>[5]</sup> I/OP2.14 — General purpose digital input/output pin.I/OD14 — External memory data line 14.P2.15/D15130 <sup>[5]</sup> I/OP2.15 — General purpose digital input/output pin.I/OD15 — External memory data line 15.P2.16/D16131 <sup>[5]</sup> I/OP2.16 — General purpose digital input/output pin.I/OD16 — External memory data line 16.				-
P2.11/D11124[5]I/OP2.11 — General purpose digital input/output pin.I/OD11 — External memory data line 11.P2.12/D12125[5]I/OP2.12 — General purpose digital input/output pin.I/OD12 — External memory data line 12.P2.13/D13127[5]I/OP2.13 — General purpose digital input/output pin.I/OD13 — External memory data line 13.P2.14/D14129[5]I/OP2.14 — General purpose digital input/output pin.I/OD14 — External memory data line 14.P2.15/D15130[5]I/OP2.15 — General purpose digital input/output pin.I/OD15 — External memory data line 15.P2.16/D16131[5]I/OP2.16 — General purpose digital input/output pin.I/OD16 — External memory data line 16.	P2.10/D10	) 120 <u>5</u>		
I/OD11 — External memory data line 11.P2.12/D12125 <sup>[5]</sup> I/OP2.12 — General purpose digital input/output pin.I/OD12 — External memory data line 12.P2.13/D13127 <sup>[5]</sup> I/OP2.13 — General purpose digital input/output pin.I/OD13 — External memory data line 13.P2.14/D14129 <sup>[5]</sup> I/OP2.14 — General purpose digital input/output pin.I/OD14 — External memory data line 14.P2.15/D15130 <sup>[5]</sup> I/OP2.15 — General purpose digital input/output pin.I/OD15 — External memory data line 15.P2.16/D16131 <sup>[5]</sup> I/OP2.16 — General purpose digital input/output pin.I/OD16 — External memory data line 16.				
P2.12/D12125 [5]I/OP2.12 — General purpose digital input/output pin.I/OD12 — External memory data line 12.P2.13/D13127 [5]I/OP2.13 — General purpose digital input/output pin.I/OD13 — External memory data line 13.P2.14/D14129 [5]I/OP2.14 — General purpose digital input/output pin.I/OD14 — External memory data line 14.P2.15/D15130 [5]I/OP2.15 — General purpose digital input/output pin.I/OD15 — External memory data line 15.P2.16/D16131 [5]I/OP2.16 — General purpose digital input/output pin.I/OD16 — External memory data line 16.	P2.11/D11	1 124 <u>5</u>		
I/OD12 — External memory data line 12.P2.13/D13127 <sup>[5]</sup> I/OP2.13 — General purpose digital input/output pin.I/OD13 — External memory data line 13.P2.14/D14129 <sup>[5]</sup> I/OP2.14 — General purpose digital input/output pin.I/OD14 — External memory data line 14.P2.15/D15130 <sup>[5]</sup> I/OP2.15 — General purpose digital input/output pin.I/OD15 — External memory data line 15.P2.16/D16131 <sup>[5]</sup> I/OP2.16 — General purpose digital input/output pin.I/OD16 — External memory data line 16.				
P2.13/D13127 <sup>[5]</sup> I/OP2.13 — General purpose digital input/output pin.I/OD13 — External memory data line 13.P2.14/D14129 <sup>[5]</sup> I/OP2.14 — General purpose digital input/output pin.I/OD14 — External memory data line 14.P2.15/D15130 <sup>[5]</sup> I/OP2.15 — General purpose digital input/output pin.I/OD15 — External memory data line 15.P2.16/D16131 <sup>[5]</sup> I/OP2.16 — General purpose digital input/output pin.I/OD16 — External memory data line 16.	P2.12/D12	2 125 <mark>5</mark>		
I/OD13 — External memory data line 13.P2.14/D14129 <sup>[5]</sup> I/OP2.14 — General purpose digital input/output pin.I/OD14 — External memory data line 14.P2.15/D15130 <sup>[5]</sup> I/OP2.15 — General purpose digital input/output pin.I/OD15 — External memory data line 15.P2.16/D16131 <sup>[5]</sup> I/OP2.16 — General purpose digital input/output pin.I/OD16 — External memory data line 16.				-
P2.14/D14129 <sup>[5]</sup> I/OP2.14 — General purpose digital input/output pin.I/OD14 — External memory data line 14.P2.15/D15130 <sup>[5]</sup> I/OP2.15 — General purpose digital input/output pin.I/OD15 — External memory data line 15.P2.16/D16131 <sup>[5]</sup> I/OP2.16 — General purpose digital input/output pin.I/OD16 — External memory data line 16.	P2.13/D13	3 127		
I/O       D14 — External memory data line 14.         P2.15/D15       130 <sup>[5]</sup> I/O       P2.15 — General purpose digital input/output pin.         I/O       D15 — External memory data line 15.         P2.16/D16       131 <sup>[5]</sup> I/O       P2.16 — General purpose digital input/output pin.         I/O       D16 — External memory data line 16.				-
P2.15/D15       130 <sup>[5]</sup> I/O       P2.15 — General purpose digital input/output pin.         I/O       D15 — External memory data line 15.         P2.16/D16       131 <sup>[5]</sup> I/O       P2.16 — General purpose digital input/output pin.         I/O       D16 — External memory data line 16.	P2.14/D14	129 <u>5</u>		
I/O       D15 — External memory data line 15.         P2.16/D16       131 <sup>[5]</sup> I/O       P2.16 — General purpose digital input/output pin.         I/O       D16 — External memory data line 16.				
P2.16/D16       131 <sup>[5]</sup> I/O       P2.16 — General purpose digital input/output pin.         I/O       D16 — External memory data line 16.	P2.15/D15	b 130		
I/O <b>D16</b> — External memory data line 16.				-
-	P2.16/D16	5 131 <u>9</u>		
P2 1 / (11) 1 200 1/() P2 17 (Conorol purpose digital input/output pin	Do 47/0 /-			-
$\frac{1}{10}  \frac{1}{10}  \frac{1}{10} $	P2.17/D17	7 132 <mark>5</mark>	I/O	P2.17 — General purpose digital input/output pin.

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### 16/32-bit ARM microcontroller with external memory interface

Symbol	Pin	Туре	Description
- P2.18/D18	133 <mark>5]</mark>	I/O	P2.18 — General purpose digital input/output pin.
		I/O	D18 — External memory data line 18.
2.19/D19	134 <mark>5</mark>	I/O	<b>P2.19</b> — General purpose digital input/output pin.
		I/O	D19 — External memory data line 19.
2.20/D20	136 <mark>5</mark>	I/O	<b>P2.20</b> — General purpose digital input/output pin.
		I/O	<b>D20</b> — External memory data line 20.
2.21/D21	137 <mark>5</mark>	I/O	P2.21 — General purpose digital input/output pin.
		I/O	D21 — External memory data line 21.
2.22/D22	1 <u>[5]</u>	I/O	P2.22 — General purpose digital input/output pin.
		I/O	D22 — External memory data line 22.
2.23/D23	10 <mark>5]</mark>	I/O	P2.23 — General purpose digital input/output pin.
		I/O	D23 — External memory data line 23.
2.24/D24	11 <u><sup>[5]</sup></u>	I/O	P2.24 — General purpose digital input/output pin.
		I/O	<b>D24</b> — External memory data line 24.
2.25/D25	12 <sup>[5]</sup>	I/O	<b>P2.25</b> — General purpose digital input/output pin.
		I/O	D25 — External memory data line 25.
2.26/D26/	13 <mark>5</mark>	I/O	P2.26 — General purpose digital input/output pin.
BOOT0		I/O	D26 — External memory data line 26.
	I	<b>BOOT0</b> — While RESET is low, together with BOOT1 controls booting and internal operation. Internal pull-up ensures high state if pin is left unconnected.	
2.27/D27/	16 <mark>5</mark>	I/O	P2.27 — General purpose digital input/output pin.
BOOT1		I/O	D27 — External memory data line 27.
		Ι	<b>BOOT1</b> — While RESET is low, together with BOOT0 controls booting and internal operation. Internal pull-up ensures high state if pin is left unconnected.
			BOOT1:0 = 00 selects 8-bit memory on CS0 for boot.
			BOOT1:0 = 01 selects 16-bit memory on CS0 for boot.
			BOOT1:0 = 10 selects 32-bit memory on CS0 for boot.
			BOOT1:0 = 11 selects internal flash memory.
2.28/D28	17 <mark>5]</mark>	I/O	P2.28 — General purpose digital input/output pin.
		I/O	D28 — External memory data line 28.
2.29/D29	18 <mark>5]</mark>	I/O	P2.29 — General purpose digital input/output pin.
		I/O	D29 — External memory data line 29.
2.30/D30/	19 <mark>[2]</mark>	I/O	P2.30 — General purpose digital input/output pin.
IN4		I/O	D30 — External memory data line 30.
		I	<b>AIN4</b> — ADC, input 4. This analog input is always connected to its pin.
2.31/D31/	20[2]	I/O	P2.31 — General purpose digital input/output pin.
IN5		I/O	D31 — External memory data line 31.
		I	AIN5 — ADC, input 5. This analog input is always connected to its pin.
P3.0 to P3.31		I/O	<b>Port 3</b> — Port 3 is a 32-bit bidirectional I/O port with individual direction controls for each bit. The operation of port 3 pins depends upon the pin function selected via the Pin Connect Block.

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### 16/32-bit ARM microcontroller with external memory interface

Symbol	Dim	Turne	Description		
Symbol	Pin	Туре	Description		
P3.0/A0	89 <u>[5]</u>	I/O	P3.0 — General purpose digital input/output pin.		
	0.0[5]	0	A0 — External memory address line 0.		
P3.1/A1	88 <u>[5]</u>	I/O	P3.1 — General purpose digital input/output pin.		
	07[5]	0	A1 — External memory address line 1.		
P3.2/A2	87 <u>5</u>	I/O	P3.2 — General purpose digital input/output pin.		
	0.4[5]	0	A2 — External memory address line 2.		
P3.3/A3	81 <u>5</u>	I/O	P3.3 — General purpose digital input/output pin.		
	[5]	0	A3 — External memory address line 3.		
P3.4/A4	80 <mark>[5]</mark>	I/O	P3.4 — General purpose digital input/output pin.		
		0	A4 — External memory address line 4.		
P3.5/A5	74 <u><sup>[5]</sup></u>	I/O	P3.5 — General purpose digital input/output pin.		
		0	A5 — External memory address line 5.		
P3.6/A6	73 <u>[5]</u>	I/O	P3.6 — General purpose digital input/output pin.		
		0	A6 — External memory address line 6.		
P3.7/A7	72 <mark>5</mark>	I/O	P3.7 — General purpose digital input/output pin.		
		0	A7 — External memory address line 7.		
P3.8/A8	71 <mark>5</mark>	I/O	P3.8 — General purpose digital input/output pin.		
		0	A8 — External memory address line 8.		
P3.9/A9	66 <mark>[5]</mark>	I/O	P3.9 — General purpose digital input/output pin.		
		0	A9 — External memory address line 9.		
P3.10/A10	65 <mark>5</mark>	65 <u>[5]</u>	65 <mark>5</mark>	I/O	P3.10 — General purpose digital input/output pin.
		0	A10 — External memory address line 10.		
P3.11/A11	64 <u>[5]</u>	I/O	P3.11 — General purpose digital input/output pin.		
		0	A11 — External memory address line 11.		
P3.12/A12	63 <mark>5</mark>	I/O	P3.12 — General purpose digital input/output pin.		
		0	A12 — External memory address line 12.		
P3.13/A13	62 <mark>5</mark>	I/O	P3.13 — General purpose digital input/output pin.		
		0	A13 — External memory address line 13.		
P3.14/A14	56 <mark>5</mark>	I/O	P3.14 — General purpose digital input/output pin.		
		0	A14 — External memory address line 14.		
P3.15/A15	55 <mark>[5]</mark>	I/O	P3.15 — General purpose digital input/output pin.		
		0	A15 — External memory address line 15.		
P3.16/A16	53 <mark>[5]</mark>	I/O	P3.16 — General purpose digital input/output pin.		
		0	A16 — External memory address line 16.		
P3.17/A17 48 <mark>5</mark>	48 <mark>5</mark>	I/O	<b>P3.17</b> — General purpose digital input/output pin.		
		0	A17 — External memory address line 17.		
P3.18/A18	47 <mark>5]</mark>	I/O	<b>P3.18</b> — General purpose digital input/output pin.		
		0	A18 — External memory address line 18.		
P3.19/A19	46 <mark>5]</mark>	I/O	<b>P3.19</b> — General purpose digital input/output pin.		
		0	A19 — External memory address line 19.		

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### 16/32-bit ARM microcontroller with external memory interface

Symbol	Pin	Туре	Description
P3.20/A20	45 <mark>5]</mark>	I/O	P3.20 — General purpose digital input/output pin.
		0	A20 — External memory address line 20.
P3.21/A21	44 <u>[5]</u>	I/O	P3.21 — General purpose digital input/output pin.
		0	A21 — External memory address line 21.
P3.22/A22	41 <u>5</u>	I/O	P3.22 — General purpose digital input/output pin.
		0	A22 — External memory address line 22.
P3.23/A23/	40[5]	I/O	P3.23 — General purpose digital input/output pin.
XCLK		I/O	A23 — External memory address line 23.
		0	XCLK — Clock output.
P3.24/CS3	36 <mark>5</mark>	I/O	P3.24 — General purpose digital input/output pin.
		0	CS3 — LOW-active Chip Select 3 signal.
			(Bank 3 addresses range 0x8300 0000 to 0x83FF FFFF)
P3.25/CS2	35 <mark>5</mark>	I/O	P3.25 — General purpose digital input/output pin.
		0	CS2 — LOW-active Chip Select 2 signal.
			(Bank 2 addresses range 0x8200 0000 to 0x82FF FFFF)
P3.26/CS1	30 <mark>5</mark>	I/O	P3.26 — General purpose digital input/output pin.
		0	CS1 — LOW-active Chip Select 1 signal.
			(Bank 1 addresses range 0x8100 0000 to 0x81FF FFFF)
P3.27/WE	29 <mark>5]</mark>	I/O	P3.27 — General purpose digital input/output pin.
		0	WE — LOW-active Write enable signal.
P3.28/BLS3/	28 <mark>[2]</mark>	I/O	P3.28 — General purpose digital input/output pin.
AIN7		0	BLS3 — LOW-active Byte Lane Select signal (Bank 3).
		I	AIN7 — ADC, input 7. This analog input is always connected to its pin.
P3.29/BLS2/	27 <mark>[4]</mark>	I/O	P3.29 — General purpose digital input/output pin.
AIN6		0	BLS2 — LOW-active Byte Lane Select signal (Bank 2).
		I	AIN6 — ADC, input 6. This analog input is always connected to its pin.
P3.30/BLS1	97 <mark>[4]</mark>	I/O	P3.30 — General purpose digital input/output pin.
		0	BLS1 — LOW-active Byte Lane Select signal (Bank 1).
P3.31/BLS0	96 <mark>[4]</mark>	I/O	P3.31 — General purpose digital input/output pin.
		0	BLS0 — LOW-active Byte Lane Select signal (Bank 0).
TD1	22 <sup>[5]</sup>	0	TD1: CAN1 transmitter output.
RESET	135 <u><sup>[6]</sup></u>	I	<b>External Reset input:</b> A LOW on this pin resets the device, causing I/O ports and peripherals to take on their default states, and processor execution to begin at address 0. TTL with hysteresis, 5 V tolerant.
XTAL1	142[7]	I	Input to the oscillator circuit and internal clock generator circuits.
XTAL2	141[7]	0	Output from the oscillator amplifier.
V <sub>SS</sub>	3, 9, 26, 38, 54, 67, 79, 93, 103, 107, 111, 128	I	Ground: 0 V reference.
V <sub>SSA</sub>	139	I	<b>Analog ground:</b> 0 V reference. This should nominally be the same voltage as $V_{SS}$ , but should be isolated to minimize noise and error.

as  $V_{SS}$ , but should be isolated to minimize noise and error.

Table 5.	Fin description	Jillinueu	
Symbol	Pin	Туре	Description
V <sub>SSA(PLL)</sub>	138	I	<b>PLL analog ground:</b> 0 V reference. This should nominally be the same voltage as V <sub>SS</sub> , but should be isolated to minimize noise and error.
V <sub>DD(1V8)</sub>	37, 110	I	<b>1.8 V core power supply:</b> This is the power supply voltage for internal circuitry.
V <sub>DDA(1V8)</sub>	143	I	<b>Analog 1.8 V core power supply:</b> This is the power supply voltage for internal circuitry. This should be nominally the same voltage as $V_{DD(1V8)}$ but should be isolated to minimize noise and error.
V <sub>DD(3V3)</sub>	2, 31, 39, 51, 57, 77, 94, 104, 112, 119	I	<b>3.3 V pad power supply:</b> This is the power supply voltage for the I/O ports.
V <sub>DDA(3V3)</sub>	14	I	Analog 3.3 V pad power supply: This should be nominally the same voltage as $V_{DD(3V3)}$ but should be isolated to minimize noise and error.

#### Table 3. Pin description ...continued

[1] 5 V tolerant pad providing digital I/O functions with TTL levels and hysteresis and 10 ns slew rate control.

[2] 5 V tolerant pad providing digital I/O functions with TTL levels and hysteresis and 10 ns slew rate control. If configured for an input function, this pad utilizes built-in glitch filter that blocks pulses shorter than 3 ns.

[3] Open-drain 5 V tolerant digital I/O I<sup>2</sup>C-bus 400 kHz specification compatible pad. It requires external pull-up to provide an output functionality.

[4] 5 V tolerant pad providing digital I/O (with TTL levels and hysteresis and 10 ns slew rate control) and analog input function. If configured for a digital input function, this pad utilizes built-in glitch filter that blocks pulses shorter than 3 ns. When configured as an ADC input, digital section of the pad is disabled.

[5] 5 V tolerant pad with built-in pull-up resistor providing digital I/O functions with TTL levels and hysteresis and 10 ns slew rate control. The pull-up resistor's value ranges from 60 k $\Omega$  to 300 k $\Omega$ .

[6] 5 V tolerant pad providing digital input (with TTL levels and hysteresis) function only.

[7] Pad provides special analog functionality.

# 6. Functional description

## 6.1 Architectural overview

The ARM7TDMI-S is a general purpose 32-bit microprocessor, which offers high performance and very low power consumption. The ARM architecture is based on RISC principles, and the instruction set and related decode mechanism are much simpler than those of microprogrammed CISC. This simplicity results in a high instruction throughput and impressive real-time interrupt response from a small and cost-effective processor core.

Pipeline techniques are employed so that all parts of the processing and memory systems can operate continuously. Typically, while one instruction is being executed, its successor is being decoded, and a third instruction is being fetched from memory.

The ARM7TDMI-S processor also employs a unique architectural strategy known as Thumb, which makes it ideally suited to high-volume applications with memory restrictions, or applications where code density is an issue.

The key idea behind Thumb is that of a super-reduced instruction set. Essentially, the ARM7TDMI-S processor has two instruction sets:

- The standard 32-bit ARM set.
- A 16-bit Thumb set.

The Thumb set's 16-bit instruction length allows it to approach twice the density of standard ARM code while retaining most of the ARM's performance advantage over a traditional 16-bit processor using 16-bit registers. This is possible because Thumb code operates on the same 32-bit register set as ARM code.

Thumb code is able to provide up to 65 % of the code size of ARM, and 160 % of the performance of an equivalent ARM processor connected to a 16-bit memory system.

### 6.2 On-chip SRAM

On-chip SRAM may be used for code and/or data storage. The SRAM may be accessed as 8-bit, 16-bit, and 32-bit. The LPC2290 provides 16 kB of SRAM and the LPC2290/01 provides 64 kB of SRAM.

### 6.3 Memory map

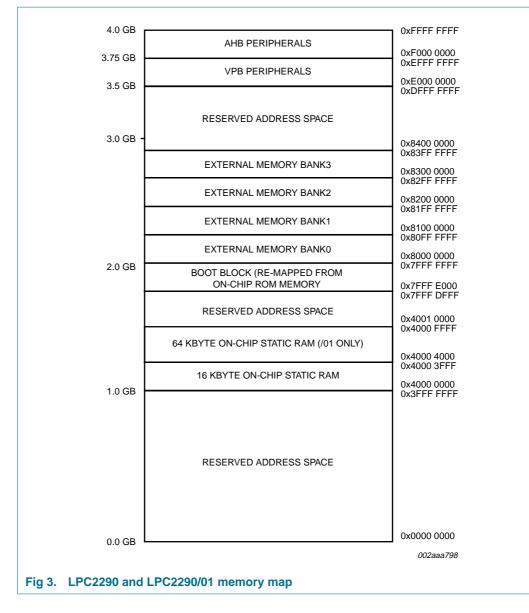
The LPC2290 memory maps incorporate several distinct regions, as shown in Figure 3.

In addition, the CPU interrupt vectors may be re-mapped to allow them to reside in either on-chip bootloader, external memory BANK0 or on-chip static RAM. This is described in Section 6.18 "System control".

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### 6.4 Interrupt controller

The Vectored Interrupt Controller (VIC) accepts all of the interrupt request inputs and categorizes them as Fast Interrupt Request (FIQ), vectored Interrupt Request (IRQ), and non-vectored IRQ as defined by programmable settings. The programmable assignment scheme means that priorities of interrupts from the various peripherals can be dynamically assigned and adjusted.

FIQ has the highest priority. If more than one request is assigned to FIQ, the VIC combines the requests to produce the FIQ signal to the ARM processor. The fastest possible FIQ latency is achieved when only one request is classified as FIQ, because then the FIQ service routine can simply start dealing with that device. But if more than one request is assigned to the FIQ class, the FIQ service routine can read a word from the VIC that identifies which FIQ source(s) is (are) requesting an interrupt.

Vectored IRQs have the middle priority. Sixteen of the interrupt requests can be assigned to this category. Any of the interrupt requests can be assigned to any of the 16 vectored IRQ slots, among which slot 0 has the highest priority and slot 15 has the lowest.

Non-vectored IRQs have the lowest priority.

The VIC combines the requests from all the vectored and non-vectored IRQs to produce the IRQ signal to the ARM processor. The IRQ service routine can start by reading a register from the VIC and jumping there. If any of the vectored IRQs are requesting, the VIC provides the address of the highest-priority requesting IRQs service routine, otherwise it provides the address of a default routine that is shared by all the non-vectored IRQs. The default routine can read another VIC register to see what IRQs are active.

#### 6.4.1 Interrupt sources

<u>Table 4</u> lists the interrupt sources for each peripheral function. Each peripheral device has one interrupt line connected to the VIC, but may have several internal interrupt flags. Individual interrupt flags may also represent more than one interrupt source.

Block	Flag(s)	VIC channel #	
WDT	Watchdog Interrupt (WDINT)	0	
-	Reserved for software interrupts only	1	
ARM Core	EmbeddedICE, DbgCommRx	2	
ARM Core	EmbeddedICE, DbgCommTx	3	
Timer 0	Match 0 to 3 (MR0, MR1, MR2, MR3)	4	
	Capture 0 to 3 (CR0, CR1, CR2, CR3)		
Timer 1	Match 0 to 3 (MR0, MR1, MR2, MR3)	5	
	Capture 0 to 3 (CR0, CR1, CR2, CR3)		
UART0	RX Line Status (RLS)	6	
	Transmit Holding Register Empty (THRE)		
	RX Data Available (RDA)		
	Character Time-out Indicator (CTI)		
	Auto-Baud Time-Out (ABTO) (available in LPC2290/01 only)		
	End of Auto-Baud (ABEO)		
UART1	RX Line Status (RLS)	7	
	Transmit Holding Register empty (THRE)		
	RX Data Available (RDA)		
	Character Time-out Indicator (CTI)		
	Modem Status Interrupt (MSI)		
	Auto-Baud Time-Out (ABTO) (available in LPC2290/01 only)		
	End of Auto-Baud (ABEO)	0	
PWM0	Match 0 to 6 (MR0, MR1, MR2, MR3, MR4, MR5, MR6)	8	
I <sup>2</sup> C-bus	SI (state change)	9	
SPI0	SPIF, MODF	10	

#### Table 4. Interrupt sources

Block	Flag(s)	VIC channel #
SPI1/SSP	Source: SPI1 SPI Interrupt Flag (SPIF), Mode Fault (MODF)	11
	Source: SSP (available in LPC2290/01 only)	
	TX FIFO at least half empty (TXRIS)	
	RX FIFO at least half full (RXRIS)	
	Receive Timeout condition (RTRIS)	
	Receive Overrun (RORRIS)	
PLL	PLL Lock (PLOCK)	12
RTC	RTCCIF (Counter Increment), RTCALF (Alarm)	13
System Control	External Interrupt 0 (EINT0)	14
	External Interrupt 1 (EINT1)	15
	External Interrupt 2 (EINT2)	16
	External Interrupt 3 (EINT3)	17
A/D	ADC	18
CAN	1 ORed CAN Acceptance Filter	19
	CAN1 (TX int, RX int)	20, 21
	CAN2 (TX int, RX int)	22, 23

### 6.5 Pin connect block

The pin connect block allows selected pins of the microcontroller to have more than one function. Configuration registers control the multiplexers to allow connection between the pin and the on-chip peripherals. Peripherals should be connected to the appropriate pins prior to being activated, and prior to any related interrupt(s) being enabled. Activity of any enabled peripheral function that is not mapped to a related pin should be considered undefined.

# 6.6 External memory controller

The external Static Memory Controller is a module which provides an interface between the system bus and external (off-chip) memory devices. It provides support for up to four independently configurable memory banks (16 MB each with byte lane enable control) simultaneously. Each memory bank is capable of supporting SRAM, ROM, flash EPROM, burst ROM memory, or some external I/O devices.

Each memory bank may be 8-bit, 16-bit, or 32-bit wide.

# 6.7 General purpose parallel I/O and Fast I/O

Device pins that are not connected to a specific peripheral function are controlled by the GPIO registers. Pins may be dynamically configured as inputs or outputs. Separate registers allow setting or clearing any number of outputs simultaneously. The value of the output register may be read back, as well as the current state of the port pins.

### 6.7.1 Features

- Direction control of individual bits.
- Separate control of output set and clear.

• All I/O default to inputs after reset.

#### 6.7.2 Fast I/O features available in LPC2290/01 only

- Fast I/O registers are located on the ARM local bus for the fastest possible I/O timing.
- All GPIO registers are byte addressable.
- Entire port value can be written in one instruction.
- Mask registers allow single instruction to set or clear any number of bits in one port.

## 6.8 10-bit ADC

The LPC2290 each contain a single 10-bit successive approximation ADC with eight multiplexed channels.

#### 6.8.1 Features

- Measurement range of 0 V to 3.3 V.
- Capable of performing more than 400000 10-bit samples per second.
- Burst conversion mode for single or multiple inputs.
- Optional conversion on transition on input pin or Timer Match signal.

#### 6.8.2 ADC features available in LPC2290/01 only

- Every analog input has a dedicated result register to reduce interrupt overhead.
- Every analog input can generate an interrupt once the conversion is completed.

### 6.9 CAN controllers and acceptance filter

The LPC2290 contains two CAN controllers. The CAN is a serial communications protocol which efficiently supports distributed real-time control with a very high level of security. Its domain of application ranges from high-speed networks to low cost multiplex wiring.

#### 6.9.1 Features

- Data rates up to 1 Mbit/s on each bus.
- 32-bit register and RAM access.
- Compatible with CAN specification 2.0B, ISO 11898-1.
- Global Acceptance Filter recognizes 11-bit and 29-bit RX identifiers for all CAN buses.
- Acceptance Filter can provide FullCAN-style automatic reception for selected Standard identifiers.
- Full CAN messages can generate interrupts.

## 6.10 UARTs

The LPC2290 contains two UARTs. In addition to standard transmit and receive data lines, UART1 also provides a full modem control handshake interface.

### 6.10.1 Features

• 16 B Receive and Transmit FIFOs.

- Register locations conform to 16C550 industry standard.
- Receiver FIFO trigger points at 1 B, 4 B, 8 B, and 14 B.
- Built-in baud rate generator.
- Standard modem interface signals included on UART1.

#### 6.10.2 UART features available in LPC2290/01 only

- The transmission FIFO control enables implementation of software (XON/XOFF) flow control on both UARTs and hardware (CTS/RTS) flow control on UART1 only.
- Fractional baud rate generator enables standard baud rates such as 115200 to be achieved with any crystal frequency above 2 MHz.
- Auto-bauding.
- Auto-CTS/RTS flow-control fully implemented in hardware.

## 6.11 I<sup>2</sup>C-bus serial I/O controller

The I<sup>2</sup>C-bus is bidirectional, for inter-IC control using only two wires: a serial clock line (SCL), and a serial data line (SDA). Each device is recognized by a unique address and can operate as either a receiver-only device (e.g., an LCD driver or a transmitter with the capability to both receive and send information (such as memory). Transmitters and/or receivers can operate in either master or slave mode, depending on whether the chip has to initiate a data transfer or is only addressed. The I<sup>2</sup>C-bus is a multi-master bus, it can be controlled by more than one bus master connected to it.

The I<sup>2</sup>C-bus implemented in LPC2290 supports bit rate up to 400 kbit/s (Fast I<sup>2</sup>C-bus).

#### 6.11.1 Features

- Compliant with standard I<sup>2</sup>C-bus interface.
- Easy to configure as master, slave, or master/slave.
- Programmable clocks allow versatile rate control.
- Bidirectional data transfer between masters and slaves.
- Multi-master bus (no central master).
- Arbitration between simultaneously transmitting masters without corruption of serial data on the bus.
- Serial clock synchronization allows devices with different bit rates to communicate via one serial bus.
- Serial clock synchronization can be used as a handshake mechanism to suspend and resume serial transfer.
- The I<sup>2</sup>C-bus may be used for test and diagnostic purposes.

## 6.12 SPI serial I/O controller

The LPC2290 contains two SPIs. The SPI is a full duplex serial interface, designed to be able to handle multiple masters and slaves connected to a given bus. Only a single master and a single slave can communicate on the interface during a given data transfer. During a data transfer the master always sends a byte of data to the slave, and the slave always sends a byte of data to the master.

#### 6.12.1 Features

- Compliant with SPI specification.
- Synchronous, serial, full duplex, communication.
- Combined SPI master and slave.
- Maximum data bit rate of one eighth of the input clock rate.

## 6.13 SSP serial I/O controller (available in LPC2290/01 only)

The LPC2290/01 contains one Serial Synchronous Port controller (SSP). The SSP controller is capable of operation on a SPI, 4-wire SSI, or Microwire bus. It can interact with multiple masters and slaves on the bus. However, only a single master and a single slave can communicate on the bus during a given data transfer. The SSP supports full duplex transfers, with frames of 4 bits to 16 bits of data flowing from the master to the slave and from the slave to the master. Often only one of these data flows carries meaningful data.

The SSP and SPI1 share the same pins on LPC2290/01. After a reset, SPI1 is enabled and SSP is disabled.

#### 6.13.1 Features

- Synchronous Serial Communication.
- 8-frame FIFOs for both transmit and receive.
- Compatible with Motorola SPI, 4-wire TI SSI and National Semiconductor Microwire buses.
- Master or slave operation.
- Four bits to 16 bits per SPI frame.

### 6.14 General purpose timers

The TIMER0 and TIMER1 are designed to count cycles of the peripheral clock (PCLK) and optionally generate interrupts or perform other actions at specified timer values, based on four match registers. It also includes four capture inputs to trap the timer value when an input signal transitions, optionally generating an interrupt. Multiple pins can be selected to perform a single capture or match function, providing an application with 'or' and 'and', as well as 'broadcast' functions among them.

#### 6.14.1 Features

- A 32-bit Timer/Counter with a programmable 32-bit prescaler.
- Four 32-bit capture channels per timer that can take a snapshot of the timer value when an input signal transitions. A capture event may also optionally generate an interrupt.
- Four 32-bit match registers that allow:
  - Continuous operation with optional interrupt generation on match.
  - Stop timer on match with optional interrupt generation.
  - Reset timer on match with optional interrupt generation.

- Four external outputs per timer corresponding to match registers, with the following capabilities:
  - Set LOW on match.
  - Set HIGH on match.
  - Toggle on match.
  - Do nothing on match.

#### 6.14.2 Timer features available in LPC2290/01 only

• Timers can count cycles of the externally supplied clock providing external event counting functionality

## 6.15 Watchdog timer

The purpose of the watchdog is to reset the microcontroller within a reasonable amount of time if it enters an erroneous state. When enabled, the watchdog will generate a system reset if the user program fails to 'feed' (or reload) the watchdog within a predetermined amount of time.

#### 6.15.1 Features

- Internally resets chip if not periodically reloaded.
- Debug mode.
- Enabled by software but requires a hardware reset or a watchdog reset/interrupt to be disabled.
- Incorrect/incomplete feed sequence causes reset/interrupt if enabled.
- Flag to indicate watchdog reset.
- Programmable 32-bit timer with internal pre-scaler.
- Selectable time period from (T<sub>cy(PCLK)</sub> × 256 × 4) to (T<sub>cy(PCLK)</sub> × 2<sup>32</sup> × 4) in multiples of T<sub>cy(PCLK)</sub> × 4.

### 6.16 Real-time clock

The Real-Time Clock (RTC) is designed to provide a set of counters to measure time when normal or idle operating mode is selected. The RTC has been designed to use little power, making it suitable for battery powered systems where the CPU is not running continuously (Idle mode).

#### 6.16.1 Features

- Measures the passage of time to maintain a calendar and clock.
- Ultra-low power design to support battery powered systems.
- Provides Seconds, Minutes, Hours, Day of Month, Month, Year, Day of Week, and Day of Year.
- Programmable Reference Clock Divider allows adjustment of the RTC to match various crystal frequencies.

## 6.17 Pulse width modulator

The PWM is based on the standard Timer block and inherits all of its features, although only the PWM function is pinned out on the LPC2290. The Timer is designed to count cycles of the peripheral clock (PCLK) and optionally generate interrupts or perform other actions when specified timer values occur, based on seven match registers. The PWM function is also based on match register events.

The ability to separately control rising and falling edge locations allows the PWM to be used for more applications. For instance, multi-phase motor control typically requires three non-overlapping PWM outputs with individual control of all three pulse widths and positions.

Two match registers can be used to provide a single edge controlled PWM output. One match register (MR0) controls the PWM cycle rate, by resetting the count upon match. The other match register controls the PWM edge position. Additional single edge controlled PWM outputs require only one match register each, since the repetition rate is the same for all PWM outputs. Multiple single edge controlled PWM outputs will all have a rising edge at the beginning of each PWM cycle, when an MR0 match occurs.

Three match registers can be used to provide a PWM output with both edges controlled. Again, the MR0 match register controls the PWM cycle rate. The other match registers control the two PWM edge positions. Additional double edge controlled PWM outputs require only two match registers each, since the repetition rate is the same for all PWM outputs.

With double edge controlled PWM outputs, specific match registers control the rising and falling edge of the output. This allows both positive going PWM pulses (when the rising edge occurs prior to the falling edge), and negative going PWM pulses (when the falling edge occurs prior to the rising edge).

## 6.17.1 Features

- Seven match registers allow up to six single edge controlled or three double edge controlled PWM outputs, or a mix of both types.
- The match registers also allow:
  - Continuous operation with optional interrupt generation on match.
  - Stop timer on match with optional interrupt generation.
  - Reset timer on match with optional interrupt generation.
- Supports single edge controlled and/or double edge controlled PWM outputs. Single edge controlled PWM outputs all go HIGH at the beginning of each cycle unless the output is a constant LOW. Double edge controlled PWM outputs can have either edge occur at any position within a cycle. This allows for both positive going and negative going pulses.
- Pulse period and width can be any number of timer counts. This allows complete flexibility in the trade-off between resolution and repetition rate. All PWM outputs will occur at the same repetition rate.
- Double edge controlled PWM outputs can be programmed to be either positive going or negative going pulses.

- Match register updates are synchronized with pulse outputs to prevent generation of erroneous pulses. Software must 'release' new match values before they can become effective.
- May be used as a standard timer if the PWM mode is not enabled.
- A 32-bit Timer/Counter with a programmable 32-bit prescaler.

# 6.18 System control

#### 6.18.1 Crystal oscillator

The oscillator supports crystals in the range of 1 MHz to 30 MHz. The oscillator output frequency is called  $f_{osc}$  and the ARM processor clock frequency is referred to as CCLK for purposes of rate equations, etc.  $f_{osc}$  and CCLK are the same value unless the PLL is running and connected. Refer to <u>Section 6.18.2 "PLL"</u> for additional information.

#### 6.18.2 PLL

The PLL accepts an input clock frequency in the range of 10 MHz to 25 MHz. The input frequency is multiplied up into the range of 10 MHz to 60 MHz with a Current Controlled Oscillator (CCO). The multiplier can be an integer value from 1 to 32 (in practice, the multiplier value cannot be higher than 6 on this family of microcontrollers due to the upper frequency limit of the CPU). The CCO operates in the range of 156 MHz to 320 MHz, so there is an additional divider in the loop to keep the CCO within its frequency range while the PLL is providing the desired output frequency. The output divider may be set to divide by 2, 4, 8, or 16 to produce the output clock. Since the minimum output divider value is 2, it is insured that the PLL output has a 50 % duty cycle. The PLL is turned off and bypassed following a chip reset and may be enabled by software. The program must configure and activate the PLL, wait for the PLL to Lock, then connect to the PLL as a clock source. The PLL settling time is 100  $\mu$ s.

#### 6.18.3 Reset and wake-up timer

Reset has two sources on the LPC2290: the RESET pin and watchdog reset. The RESET pin is a Schmitt trigger input pin with an additional glitch filter. Assertion of chip reset by any source starts the Wake-up Timer (see Wake-up Timer description below), causing the internal chip reset to remain asserted until the external reset is de-asserted, the oscillator is running, a fixed number of clocks have passed, and the on-chip flash controller has completed its initialization.

When the internal reset is removed, the processor begins executing at address 0, which is the reset vector. At that point, all of the processor and peripheral registers have been initialized to predetermined values.

The Wake-up Timer ensures that the oscillator and other analog functions required for chip operation are fully functional before the processor is allowed to execute instructions. This is important at power-on, all types of reset, and whenever any of the aforementioned functions are turned off for any reason. Since the oscillator and other functions are turned off during Power-down mode, any wake-up of the processor from Power-down mode makes use of the Wake-up Timer.

The Wake-up Timer monitors the crystal oscillator as the means of checking whether it is safe to begin code execution. When power is applied to the chip, or some event caused the chip to exit Power-down mode, some time is required for the oscillator to produce a signal of sufficient amplitude to drive the clock logic. The amount of time depends on many factors, including the rate of  $V_{DD}$  ramp (in the case of power-on), the type of crystal and its electrical characteristics (if a quartz crystal is used), as well as any other external circuitry (e.g. capacitors), and the characteristics of the oscillator itself under the existing ambient conditions.

#### 6.18.4 External interrupt inputs

The LPC2290 include up to nine edge or level sensitive External Interrupt Inputs as selectable pin functions. When the pins are combined, external events can be processed as four independent interrupt signals. The External Interrupt Inputs can optionally be used to wake up the processor from Power-down mode.

#### 6.18.5 Memory mapping control

The Memory Mapping Control alters the mapping of the interrupt vectors that appear beginning at address 0x0000 0000. Vectors may be mapped to the bottom of the on-chip flash memory, or to the on-chip static RAM. This allows code running in different memory spaces to have control of the interrupts.

#### 6.18.6 Power control

The LPC2290 support two reduced power modes: Idle mode and Power-down mode. In Idle mode, execution of instructions is suspended until either a reset or interrupt occurs. Peripheral functions continue operation during Idle mode and may generate interrupts to cause the processor to resume execution. Idle mode eliminates power used by the processor itself, memory systems and related controllers, and internal buses.

In Power-down mode, the oscillator is shut down and the chip receives no internal clocks. The processor state and registers, peripheral registers, and internal SRAM values are preserved throughout Power-down mode and the logic levels of chip output pins remain static. The Power-down mode can be terminated and normal operation resumed by either a reset or certain specific interrupts that are able to function without clocks. Since all dynamic operation of the chip is suspended, Power-down mode reduces chip power consumption to nearly zero.

A Power Control for Peripherals feature allows individual peripherals to be turned off if they are not needed in the application, resulting in additional power savings.

#### 6.18.7 APB bus

The APB divider determines the relationship between the processor clock (CCLK) and the clock used by peripheral devices (PCLK). The APB divider serves two purposes. The first is to provide peripherals with the desired PCLK via APB bus so that they can operate at the speed chosen for the ARM processor. In order to achieve this, the APB bus may be slowed down to  $1/_2$  to  $1/_4$  of the processor clock rate. Because the APB bus must work properly at power-up (and its timing cannot be altered if it does not work since the APB divider control registers reside on the APB bus), the default condition at reset is for the APB bus to run at  $1/_4$  of the processor clock rate. The second purpose of the APB divider is to allow power savings when an application does not require any peripherals to run at the full processor rate. Because the APB divider is connected to the PLL output, the PLL remains active (if it was running) during Idle mode.

## 6.19 Emulation and debugging

The LPC2290 support emulation and debugging via a JTAG serial port. A trace port allows tracing program execution. Debugging and trace functions are multiplexed only with GPIOs on Port 1. This means that all communication, timer and interface peripherals residing on Port 0 are available during the development and debugging phase as they are when the application is run in the embedded system itself.

#### 6.19.1 EmbeddedICE

Standard ARM EmbeddedICE logic provides on-chip debug support. The debugging of the target system requires a host computer running the debugger software and an EmbeddedICE protocol convertor. EmbeddedICE protocol convertor converts the remote debug protocol commands to the JTAG data needed to access the ARM core.

The ARM core has a Debug Communication Channel function built-in. The debug communication channel allows a program running on the target to communicate with the host debugger or another separate host without stopping the program flow or even entering the debug state. The debug communication channel is accessed as a coprocessor 14 by the program running on the ARM7TDMI-S core. The debug communication channel allows the JTAG port to be used for sending and receiving data without affecting the normal program flow. The debug communication channel data and control registers are mapped in to addresses in the EmbeddedICE logic.

#### 6.19.2 Embedded trace

Since the LPC2290 has significant amounts of on-chip memory, it is not possible to determine how the processor core is operating simply by observing the external pins. The Embedded Trace Macrocell (ETM) provides real-time trace capability for deeply embedded processor cores. It outputs information about processor execution to the trace port.

The ETM is connected directly to the ARM core and not to the main AMBA system bus. It compresses the trace information and exports it through a narrow trace port. An external trace port analyzer must capture the trace information under software debugger control. Instruction trace (or PC trace) shows the flow of execution of the processor and provides a list of all the instructions that were executed. Instruction trace is significantly compressed by only broadcasting branch addresses as well as a set of status signals that indicate the pipeline status on a cycle by cycle basis. Trace information generation can be controlled by selecting the trigger resource. Trigger resources include address comparators, counters and sequencers. Since trace information is compressed the software debugger requires a static image of the code being executed. Self-modifying code can not be traced because of this restriction.

### 6.19.3 RealMonitor

RealMonitor is a configurable software module, developed by ARM Inc., which enables real-time debug. It is a lightweight debug monitor that runs in the background while users debug their foreground application. It communicates with the host using the DCC (Debug Communications Channel), which is present in the EmbeddedICE logic. The LPC2290 contain a specific configuration of RealMonitor software programmed into the on-chip flash memory.

# 7. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).[1]

		0, ( )			
Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>DD(1V8)</sub>	supply voltage (1.8 V)	internal rail	-0.5	+2.5	V
V <sub>DD(3V3)</sub>	supply voltage (3.3 V)	external rail	-0.5	+3.6	V
V <sub>DDA(3V3)</sub>	analog supply voltage (3.3 V)		-0.5	+4.6	V
VIA	analog input voltage		-0.5	+5.1	V
VI	input voltage	5 V tolerant I/O pins	[2][3] -0.5	+6.0	V
		other I/O pins	[2][4] -0.5	$V_{DD(3V3)} + 0.5$	V
I <sub>DD</sub>	supply current	per supply pin	<u>[5]</u>	100	mA
I <sub>SS</sub>	ground current	per ground pin	<u>[5]</u>	100	mA
T <sub>stg</sub>	storage temperature		<u>6</u> –65	+150	°C
P <sub>tot(pack)</sub>	total power dissipation (per package)	based on package heat transfer, not device power consumption	-	1.5	W
V <sub>esd</sub>	electrostatic discharge voltage	human body model; all pins	[7] –2000	+2000	V

[1] The following applies to Table 5:

a) This product includes circuitry specifically designed for the protection of its internal devices from the damaging effects of excessive static charge. Nonetheless, it is suggested that conventional precautions be taken to avoid applying greater than the rated maximum.

b) Parameters are valid over operating temperature range unless otherwise specified. All voltages are with respect to V<sub>SS</sub> unless otherwise noted.

[2] Including voltage on outputs in 3-state mode.

[3] Only valid when the  $V_{DD(3V3)}$  supply voltage is present.

[4] Not to exceed 4.6 V.

[5] The peak current is limited to 25 times the corresponding maximum current.

[6] Dependent on package type.

[7] Human body model: equivalent to discharging a 100 pF capacitor through a 1.5 k $\Omega$  series resistor.

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# 8. Static characteristics

#### Table 6. Static characteristics

 $T_{amb} = -40 \circ C$  to +85  $\circ C$  for industrial applications, unless otherwise specified.

Symbol	Parameter	Conditions		Min	Typ <mark>[1]</mark>	Max	Unit
V <sub>DD(1V8)</sub>	supply voltage (1.8 V)	internal rail		1.65	1.8	1.95	V
V <sub>DD(3V3)</sub>	supply voltage (3.3 V)	external rail		3.0	3.3	3.6	V
V <sub>DDA(3V3)</sub>	analog supply voltage (3.3 V)			2.5	3.3	3.6	V
Standard	port pins, RESET, RTCK						
IIL	LOW-level input current	V <sub>I</sub> = 0 V; no pull-up		-	-	3	μΑ
I <sub>IH</sub>	HIGH-level input current	$V_{I} = V_{DD(3V3)}$ ; no pull-down		-	-	3	μΑ
I <sub>OZ</sub>	OFF-state output current	$V_O = 0 V$ , $V_O = V_{DD(3V3)}$ ; no pull-up/down		-	-	3	μA
I <sub>latch</sub>	I/O latch-up current	–(0.5V <sub>DD(3V3)</sub> ) < V <sub>I</sub> < (1.5V <sub>DD(3V3)</sub> ); T <sub>j</sub> < 125 °C		100	-	-	mA
VI	input voltage		[2][3][4]	0	-	5.5	V
Vo	output voltage	output active		0	-	V <sub>DD(3V3)</sub>	V
VIH	HIGH-level input voltage			2.0	-	-	V
VIL	LOW-level input voltage			-	-	0.8	V
V <sub>hys</sub>	hysteresis voltage			-	0.4	-	V
V <sub>OH</sub>	HIGH-level output voltage	$I_{OH} = -4 \text{ mA}$	[5]	$V_{DD(3V3)} - 0.4$	-	-	V
V <sub>OL</sub>	LOW-level output voltage	$I_{OL} = -4 \text{ mA}$	[5]	-	-	0.4	V
I <sub>OH</sub>	HIGH-level output current	$V_{OH} = V_{DD(3V3)} - 0.4 V$	[5]	-4	-	-	mA
I <sub>OL</sub>	LOW-level output current	$V_{OL} = 0.4 V$	[5]	4	-	-	mA
I <sub>OHS</sub>	HIGH-level short-circuit output current	V <sub>OH</sub> = 0 V	[6]	-	-	-45	mA
I <sub>OLS</sub>	LOW-level short-circuit output current	$V_{OL} = V_{DD(3V3)}$	<u>[6]</u>	-	-	50	mA
I <sub>pd</sub>	pull-down current	V <sub>I</sub> = 5 V	[7]	10	50	150	μΑ
l <sub>pu</sub>	pull-up current	$V_I = 0 V$	[8]	–15	-50	-85	μΑ
		V <sub>DD(3V3)</sub> < V <sub>I</sub> < 5 V	[7]	0	0	0	μΑ
I <sub>DD(act)</sub>	active mode supply current	$\begin{split} V_{DD(1V8)} &= 1.8 \text{ V}, \\ CCLK &= 60 \text{ MHz}, \\ T_{amb} &= 25 \text{ °C}, \text{ code} \end{split}$		-	50	-	mA
		<pre>while(1){} executed from flash, no active peripherals</pre>					
I <sub>DD(pd)</sub>	Power-down mode supply current	$V_{DD(1V8)} = 1.8 V,$ $T_{amb} = 25 \ ^{\circ}C,$		-	10	-	μA
		$V_{DD(1V8)} = 1.8 V,$ $T_{amb} = 85 \ ^{\circ}C$		-	110	500	μA
		$V_{DD(1V8)} = 1.8 V,$ $T_{amb} = 125 \ ^{\circ}C$		-	300	1000	μA

# LPC2290

#### 16/32-bit ARM microcontroller with external memory interface

#### Conditions Typ[1] Symbol Parameter Min Max Unit I<sup>2</sup>C-bus pins 0.7V<sub>DD(3V3)</sub> V HIGH-level input voltage $V_{IH}$ -\_ VIL LOW-level input voltage 0.3V<sub>DD(3V3)</sub> \_ -V hysteresis voltage V<sub>hys</sub> 0.5V<sub>DD(3V3)</sub> V -[5] \_ VOL LOW-level output voltage $I_{OLS} = 3 \text{ mA}$ -0.4 V input leakage current $V_{I} = V_{DD(3V3)}$ ; to $V_{SS}$ 2 4 $I_{LI}$ \_ μΑ $V_1 = 5 V$ 10 22 μΑ -**Oscillator pins** input voltage on pin 0 1.8 V $V_{i(XTAL1)}$ -XTAL1 output voltage on pin 0 V $V_{o(XTAL2)}$ 1.8 -XTAL2

#### Table 6. Static characteristics ... continued

 $T_{amb} = -40 \circ C$  to +85  $\circ C$  for industrial applications, unless otherwise specified.

[1] Typical ratings are not guaranteed. The values listed are at room temperature (+25 °C), nominal supply voltages.

[2] Including voltage on outputs in 3-state mode.

[3] V<sub>DD(3V3)</sub> supply voltages must be present.

[4] 3-state outputs go into 3-state mode when  $V_{DD(3V3)}$  is grounded.

[5] Accounts for 100 mV voltage drop in all supply lines.

[6] Only allowed for a short time period.

[7] Minimum condition for  $V_1 = 4.5$  V, maximum condition for  $V_1 = 5.5$  V.

[8] Applies to P1[25:16].

**Product data sheet** 

LPC2290 3

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
VIA	analog input voltage		0	-	V <sub>DDA</sub>	V
C <sub>ia</sub>	analog input capacitance		-	-	1	pF
E <sub>D</sub>	differential linearity error		- [1][2][3]	-	±1	LSB
E <sub>L(adj)</sub>	integral non-linearity		<u>[1][4]</u>	-	±2	LSB
E <sub>O</sub>	offset error		<u>[1][5]</u>	-	±3	LSB
E <sub>G</sub>	gain error		[1][6]	-	±0.5	%
ET	absolute error		<u>[1][7]</u> _	-	±4	LSB

#### Table 7. ADC static characteristics

 $V_{DDA} = 2.5 \text{ V to } 3.6 \text{ V}$ :  $T_{amb} = -40 \text{ °C to } +125 \text{ °C unless otherwise specified. ADC frequency 4.5 MHz.$ 

[1] Conditions:  $V_{SSA} = 0$  V,  $V_{DDA} = 3.3$  V.

[2] The ADC is monotonic, there are no missing codes.

[3] The differential linearity error (E<sub>D</sub>) is the difference between the actual step width and the ideal step width. See Figure 4.

[4] The integral non-linearity (E<sub>L(adj)</sub>) is the peak difference between the center of the steps of the actual and the ideal transfer curve after appropriate adjustment of gain and offset errors. See Figure 4.

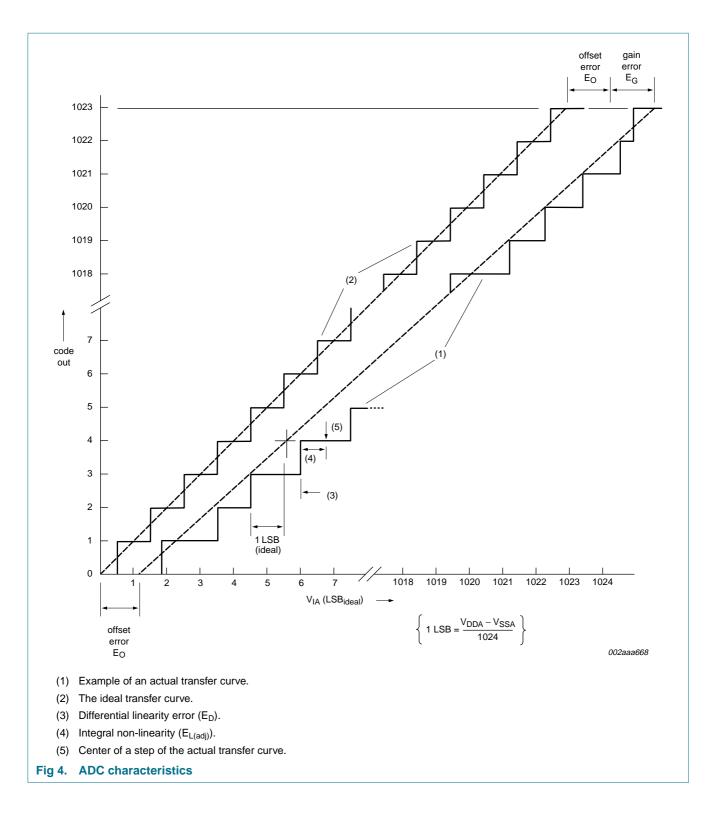
[5] The offset error ( $E_0$ ) is the absolute difference between the straight line which fits the actual curve and the straight line which fits the ideal curve. See Figure 4.

[6] The gain error (E<sub>G</sub>) is the relative difference in percent between the straight line fitting the actual transfer curve after removing offset error, and the straight line which fits the ideal transfer curve. See Figure 4.

[7] The absolute voltage error (E<sub>T</sub>) is the maximum difference between the center of the steps of the actual transfer curve of the non-calibrated ADC and the ideal transfer curve. See Figure 4.

# LPC2290

#### 16/32-bit ARM microcontroller with external memory interface



# 9. Dynamic characteristics

#### Table 8. Dynamic characteristics

 $T_{amb} = -40 \circ C$  to  $+125 \circ C$ ;  $V_{DD(1V8)}$ ,  $V_{DD(3V3)}$  over specified ranges.<sup>[1]</sup>

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
External cloc	:k					
f <sub>osc</sub>	oscillator frequency	supplied by an external oscillator (signal generator)	1	-	50	MHz
		external clock frequency supplied by an external crystal oscillator	1	-	30	MHz
		external clock frequency if on-chip PLL is used	10	-	25	MHz
		external clock frequency if on-chip bootloader is used for initial code download	10	-	25	MHz
T <sub>cy(clk)</sub>	clock cycle time		20	-	1000	ns
t <sub>CHCX</sub>	clock HIGH time		$\rm T_{cy(clk)} \times 0.4$	-	-	ns
t <sub>CLCX</sub>	clock LOW time		$\rm T_{cy(clk)} \times 0.4$	-	-	ns
t <sub>CLCH</sub>	clock rise time		-	-	5	ns
t <sub>CHCL</sub>	clock fall time		-	-	5	ns
Port pins (ex	cept P0.2 and P0.3)					
t <sub>r</sub>	rise time		-	10	-	ns
t <sub>f</sub>	fall time		-	10	-	ns
I <sup>2</sup> C-bus pins	(P0.2 and P0.3)					
t <sub>f</sub>	fall time	V <sub>IH</sub> to V <sub>IL</sub>	[2] 20 + 0.1 × C <sub>b</sub>	-	-	ns

[1] Parameters are valid over operating temperature range unless otherwise specified.

[2] Bus capacitance  $C_b$  in pF, from 10 pF to 400 pF.

# LPC2290

#### 16/32-bit ARM microcontroller with external memory interface

#### Table 9. External memory interface dynamic characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Common	to read and write cycles						
t <sub>CHAV</sub>	XCLK HIGH to address valid time			-	-	10	ns
t <sub>CHCSL</sub>	XCLK HIGH to CS LOW time			-	-	10	ns
t <sub>CHCSH</sub>	XCLK HIGH to CS HIGH time			-	-	10	ns
t <sub>CHANV</sub>	XCLK HIGH to address invalid time			-	-	10	ns
Read cyc	e parameters						
t <sub>CSLAV</sub>	CS LOW to address valid time		<u>[1]</u>	-5	-	+10	ns
t <sub>OELAV</sub>	OE LOW to address valid time		<u>[1]</u>	-5	-	+10	ns
t <sub>CSLOEL</sub>	CS LOW to OE LOW time			-5	-	+5	ns
t <sub>am</sub>	memory access time	[2		$(T_{cy(CCLK)} \times (2 + WST1)) + (-20)$	-	-	ns
t <sub>am(ibr)</sub>	memory access time (initial burst-ROM)	[2		$(T_{cy(CCLK)} \times (2 + WST1)) + (-20)$	-	-	ns
t <sub>am(sbr)</sub>	memory access time (subsequent burst-ROM)	[2	? <u>][4]</u>	T <sub>cy(CCLK)</sub> + (-20)	-	-	ns
t <sub>h(D)</sub>	data hold time		[5]	0	-	-	ns
t <sub>CSHOEH</sub>	CS HIGH to OE HIGH time			-5	-	+5	ns
t <sub>OEHANV</sub>	OE HIGH to address invalid time			-5	-	+5	ns
t <sub>CHOEL</sub>	XCLK HIGH to OE LOW time			-5	-	+5	ns
tсноен	XCLK HIGH to OE HIGH time			-5	-	+5	ns
Write cyc	le parameters						
t <sub>AVCSL</sub>	address valid to CS LOW time		<u>[1]</u>	$T_{cy(CCLK)} - 10$	-	-	ns
t <sub>CSLDV</sub>	CS LOW to data valid time			-5	-	+5	ns
t <sub>CSLWEL</sub>	CS LOW to WE LOW time			-5	-	+5	ns
t <sub>CSLBLSL</sub>	CS LOW to BLS LOW time			-5	-	+5	ns
t <sub>WELDV</sub>	WE LOW to data valid time			-5	-	+5	ns
t <sub>CSLDV</sub>	CS LOW to data valid time			-5	-	+5	ns
t <sub>WELWEH</sub>	WE LOW to WE HIGH time		[2]	$T_{cy(CCLK)}  imes (1 + WST2) - 5$	-	$T_{cy(CCLK)} \times (1 + WST2) + 5$	ns
t <sub>BLSLBLSH</sub>	BLS LOW to BLS HIGH time		[2]	$T_{cy(CCLK)} \times (1 + WST2) - 5$	-	$T_{cy(CCLK)} \times$ (1 + WST2) + 5	ns
t <sub>WEHANV</sub>	WE HIGH to address invalid time		[2]	$T_{cy(CCLK)} - 5$	-	$T_{cy(CCLK)}$ + 5	ns
t <sub>WEHDNV</sub>	WE HIGH to data invalid time		[2]	$(2 \times T_{cy(CCLK)}) - 5$	-	$(2 \times T_{cy(CCLK)}) + 5$	ns
t <sub>BLSHANV</sub>	BLS HIGH to address invalid time		[2]	$T_{cy(CCLK)} - 5$	-	$T_{cy(CCLK)}$ + 5	ns

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
t <sub>BLSHDNV</sub>	BLS HIGH to data invalid time		[2] (2 × T <sub>cy(CCLK)</sub> ) – 5	-	$(2 \times T_{cy(CCLK)}) + 5$	ns
t <sub>CHDV</sub>	XCLK HIGH to data valid time		-	-	10	ns
t <sub>CHWEL</sub>	XCLK HIGH to WE LOW time		-	-	10	ns
t <sub>CHBLSL</sub>	XCLK HIGH to BLS LOW time		-	-	10	ns
t <sub>CHWEH</sub>	XCLK HIGH to WE HIGH time		-	-	10	ns
t <sub>CHBLSH</sub>	XCLK HIGH to BLS HIGH time		-	-	10	ns
t <sub>CHDNV</sub>	XCLK HIGH to data invalid time		-	-	10	ns

#### Table 9. External memory interface dynamic characteristics ... continued

[1] Except on initial access, in which case the address is set up  $T_{cy(CCLK)}$  earlier.

[2]  $T_{cy(CCLK)} = \frac{1}{CCLK}$ 

[3] Latest of address valid, CS LOW, OE LOW to data valid.

[4] Address valid to data valid.

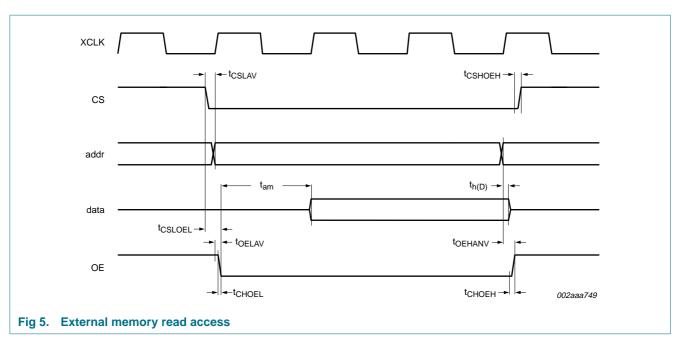
[5] Earliest of CS HIGH, OE HIGH, address change to data invalid.

#### Table 10. Standard read access specifications

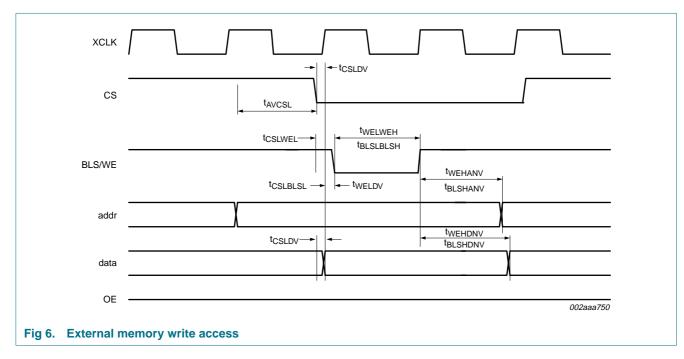
Access cycle	Max frequency	WST setting WST $\ge$ 0; round up to integer	Memory access time requirement
standard read	$f_{MAX} \le \frac{2 + WST1}{t_{RAM} + 20 \ ns}$	$WST1 \ge \frac{t_{RAM} + 20 \ ns}{t_{cy(CCLK)}} - 2$	$t_{RAM} \le t_{cy(CCLK)} \times (2 + WST1) - 20 \ ns$
standard write	$f_{MAX} \le \frac{1 + WST2}{t_{WRITE} + 5 \ ns}$	$WST2 \ge \frac{t_{WRITE} - t_{CYC} + 5}{t_{cy(CCLK)}}$	$t_{WRITE} \le t_{cy(CCLK)} \times (1 + WST2) - 5 \ ns$
burst read - initial	$f_{MAX} \le \frac{2 + WST1}{t_{INIT} + 20 \ ns}$	$WST1 \ge \frac{t_{INIT} + 20 \ ns}{t_{cy(CCLK)}} - 2$	$t_{INIT} \le t_{cy(CCLK)} \times (2 + WST1) - 20 \ ns$
burst read - subsequent 3×	$f_{MAX} \le \frac{1}{t_{ROM} + 20 \ ns}$	N/A	$t_{ROM} \le t_{cy(CCLK)} - 20 \ ns$

# LPC2290

#### 16/32-bit ARM microcontroller with external memory interface

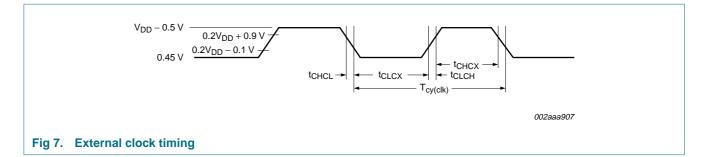


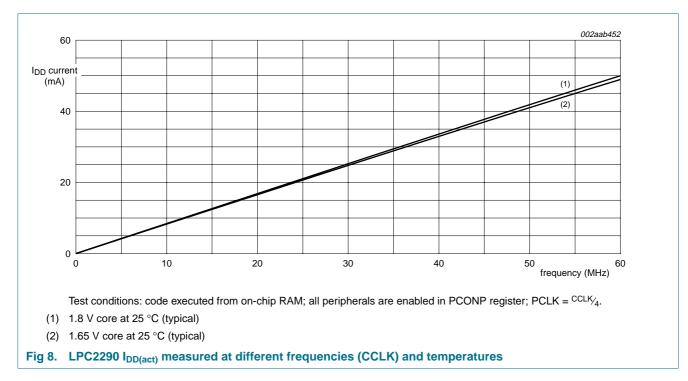
# 9.1 Timing



# LPC2290

#### 16/32-bit ARM microcontroller with external memory interface

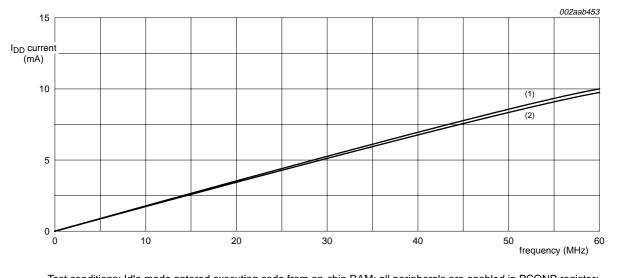




# 9.2 LPC2290 power consumption measurements

# LPC2290

#### 16/32-bit ARM microcontroller with external memory interface

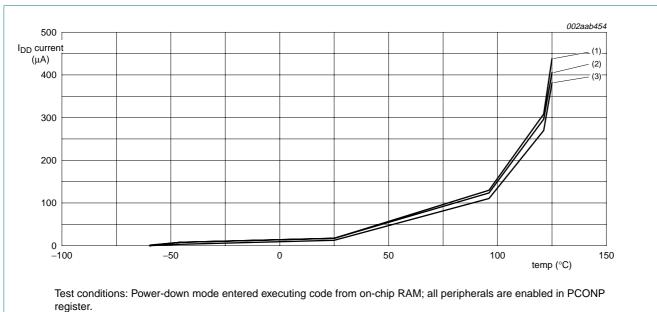


Test conditions: Idle mode entered executing code from on-chip RAM; all peripherals are enabled in PCONP register;  $PCLK = CCLK_4$ .

(1) 1.8 V core at 25 °C (typical)

(2) 1.65 V core at 25 °C (typical)

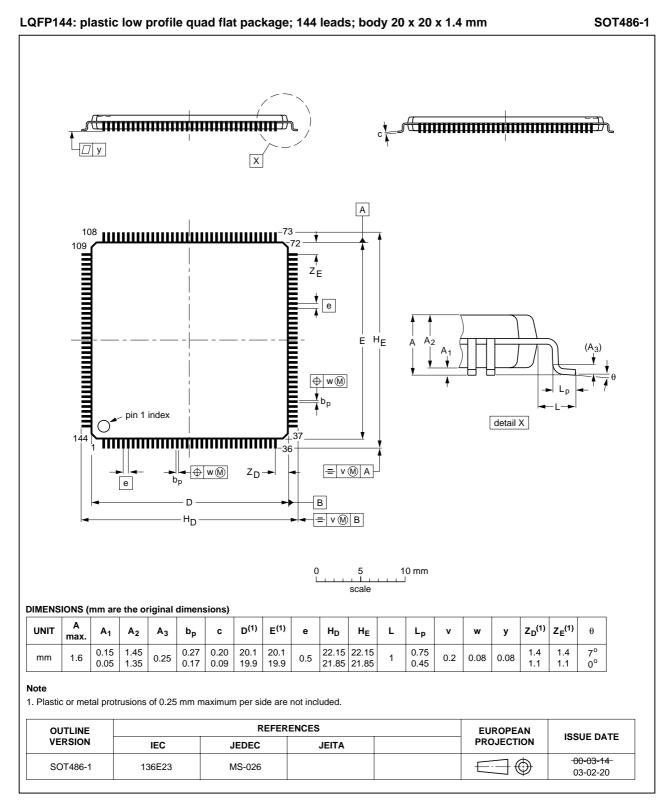
Fig 9. LPC2290  $I_{DD}$  idle measured at different frequencies (CCLK) and temperatures



- (1) 1.95 V core
- (2) 1.8 V core
- (3) 1.65 V core

Fig 10. LPC2290 I<sub>DD(pd)</sub> measured at different temperatures

# 10. Package outline



#### Fig 11. Package outline SOT486-1 (LQFP144)

# **11. Abbreviations**

Table 11.	Abbreviations
Acronym	Description
ADC	Analog-to-Digital Converter
AMBA	Advanced Microcontroller Bus Architecture
APB	AMBA Peripheral Bus
CAN	Controller Area Network
CISC	Complex Instruction Set Computer
CPU	Central Processing Unit
FIFO	First In, First Out
GPIO	General Purpose Input/Output
PLL	Phase-Locked Loop
PWM	Pulse Width Modulator
RAM	Random Access Memory
RISC	Reduced Instruction Set Computer
SPI	Serial Peripheral Interface
SRAM	Static Random Access Memory
SSP	Synchronous Serial Port
TTL	Transistor-Transistor Logic
UART	Universal Asynchronous Receiver/Transmitter

# 12. Revision history

LPC2290_320061116ProModifications:• The format of this of		Change notice	Supersedes			
Modifications: • The format of this of			Caporocauco			
	oduct data sheet	-	LPC2290-02			
C C	data sheet has been redes Semiconductors. Deen adapted to the new co	-				
<ul> <li>New features specific to the LPC2290/01 have been added throughout.</li> </ul>						
LPC2290-02 20041223 Pro	oduct data	-	LPC2290-01			
LPC2290-01 20040209 Pre			_			

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Document status <sup>[1][2]</sup>	Product status <sup>[3]</sup>	Definition
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[2] The term 'short data sheet' is explained in section "Definitions".

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